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SHARP®

DISPLAY DEVICE BUSINESS DIVISION
SHARP CORPORATION

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APPLICABLE DIVISION

DEVELOPMENT DEPARTMENT 2
DISPLAY DEVICE UNIT 1

SPECIFICATION

DEVICE SPECIFICATION for
CGS Color LCD Module
(1440 × RGB × 2560 dots)

Model No.

LS055R1SX03

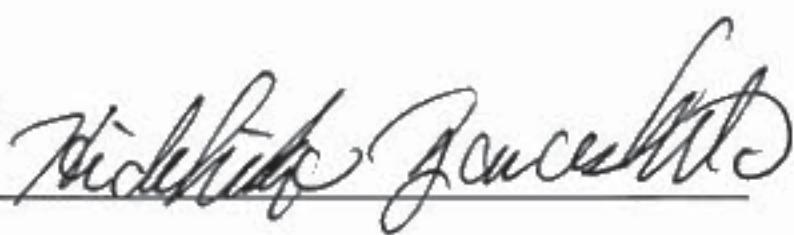
Customer model No.

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PRESENTED
BY



Yasutomo Nishihara
Manager
DEVELOPMENT DEPARTMENT 1
DISPLAY DEVICE UNIT 1
DISPLAY DEVICE BUSINESS DIVISION
SHARP CORPORATION

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| DATE | REF.PAGE PARAGRAPH DRAWING No. | REVISED NO. | SUMMARY | |
| 04.Apr.2014 | | | First Issue | |
| 09.May.2014 | P.5 | A | Mechanical Specification updated (Module Mass) | |
| | P.7 | | Current consumption modification | |
| | P.23,26 | | To add Optical parameter (response time) Viewing angle condition changed | |
| | P.27-29 | | Packaging specifications updated | |
| 09.Sep.2014 | P.18 & P.19 | B | Power on sequence modification (tsAVP : 1ms=>200ms) | |
| | P.31 | | To update the outline dimension | |
| 13.Jul.2015 | P.30 | C | To update the Serial Number Label identification | |
| 15.Jun.2016 | P.8 | D | To modify the number of LED | |
| | | | | |
| | | | | |

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[For handling and system design]

- (1) Do not scratch the surface of the polarizer film as it is easily damaged.
- (2) If the cleaning of the surface of the LCD panel is necessary, wipe it swiftly with cotton or other soft cloth. Do not use organic solvent as it damages polarizer.
- (3) Water droplets on polarizer must be wiped off immediately as they may cause color changes, or other defects if remained for a long time.
- (4) Since this LCD panel is made of glass, dropping the module or banging it against hard objects may cause cracks or fragmentation.
- (5) Certain materials such as epoxy resin (amine's hardener) or silicone adhesive agent (de-alcohol or de-oxym) emits gas to which polarizer reacts (color change). Check carefully that gas from materials used in system housing or packaging do not hurt polarizer.
- (6) Liquid crystal material will freeze below specified storage temperature range and it will not get back to normal quality even after temperature comes back within specified temperature range. Liquid crystal material will become isotropic above specified temperature range and may not get back to normal quality. Keep the LCD module always within specified temperature range.
- (7) Do not expose LCD module to the direct sunlight or to strong ultraviolet light for long time.
- (8) If the LCD driver IC (COG) is exposed to light, normal operation may be impeded. It is necessary to design so that the light is shut off when the LCD module is mounted.

(9) Do not disassemble the LCD module as it may cause permanent damage.

(10) As this LCD module contains components sensitive to electrostatic discharge, be sure to follow the instructions in below.

① Operators

Operators must wear anti-static wears to prevent electrostatic charge up to and discharge from human body.

② Equipment and containers

Process equipment such as conveyer, soldering iron, working bench and containers may possibly generate electrostatic charge up and discharge. Equipment must be grounded through 100Mohms resistance. Use ion blower.

③ Floor

Floor is an important part to leak static electricity which is generated from human body or equipment.

There is a possibility that the static electricity is charged to them without leakage in case of insulating floor, so the counter measure (electrostatic earth: $1\times 10^8\Omega$) should be made.

④ Humidity

Proper humidity of working room may reduce the risk of electrostatic charge up and discharge. Humidity should be kept over 50% all the time.

⑤ Transportation/storage

Storage materials must be anti-static to prevent causing electrostatic discharge.

⑥ Others

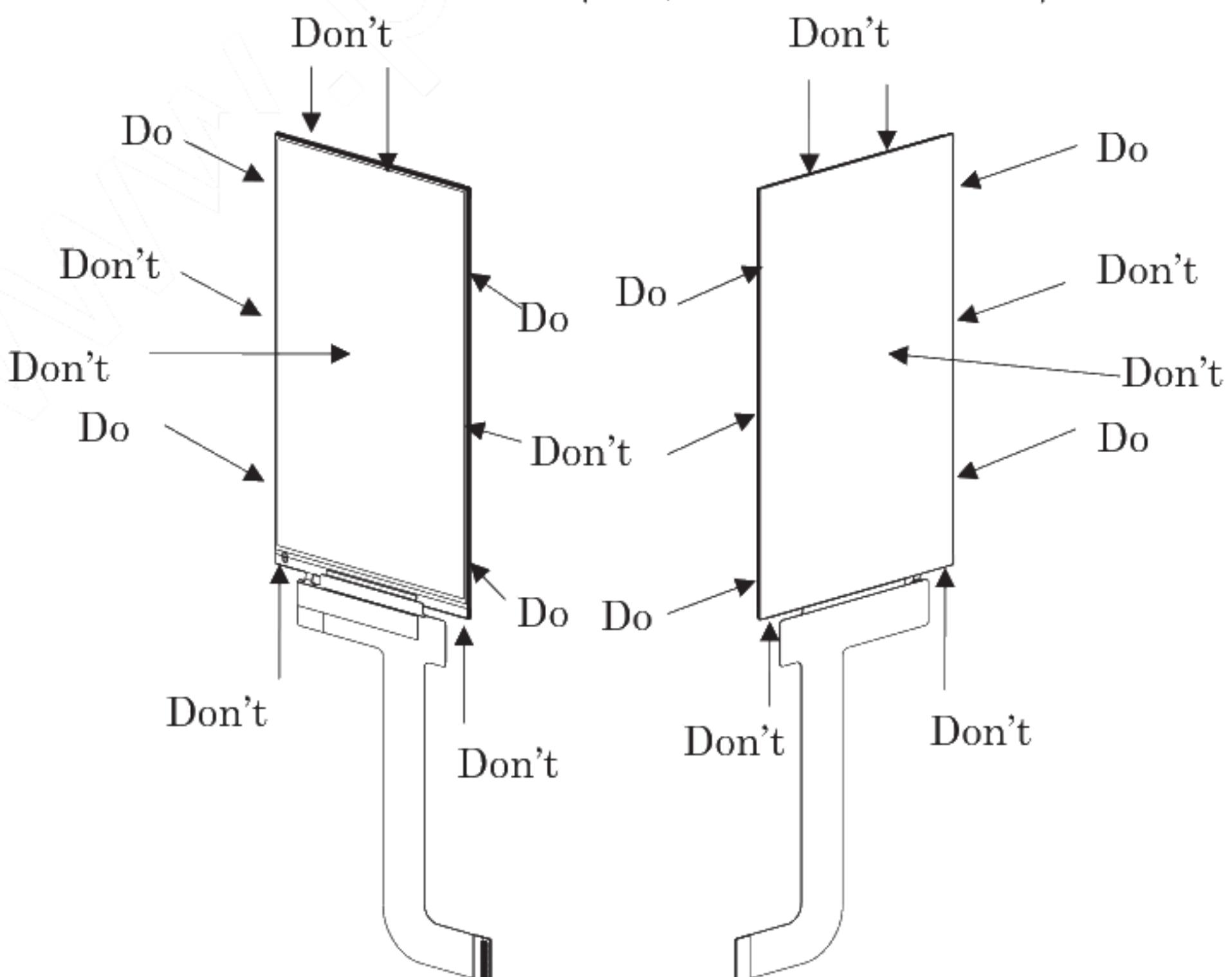
Protective film is attached on the surface of LCD panel to prevent scratches or other damages. When removing this protective film, remove it slowly under proper anti-ESD control such as ion blower.

(11) Hold LCD very carefully when placing LCD module into the system housing. Do not apply excessive stress or pressure to LCD module. Do not to use chloroprene rubber as it may affect on the reliability of the electrical interconnection.

(12) Do not hold or touch LCD panel to flex interconnection area as it may be damaged.

(13) As the binding material between LCD panel and flex connector mentioned in 12) contains an organic material, any type of organic solvents are not allowed to be used. Direct contact by fingers is also prohibited.

(14) When carrying the LCD module, place it on the tray to protect from mechanical damage. It is recommended to use the conductive trays to protect the CMOS components from electrostatic discharge. When holding the module, hold the Plastic Frame of LCD module so that the panel, COG and other electric parts are not damaged.



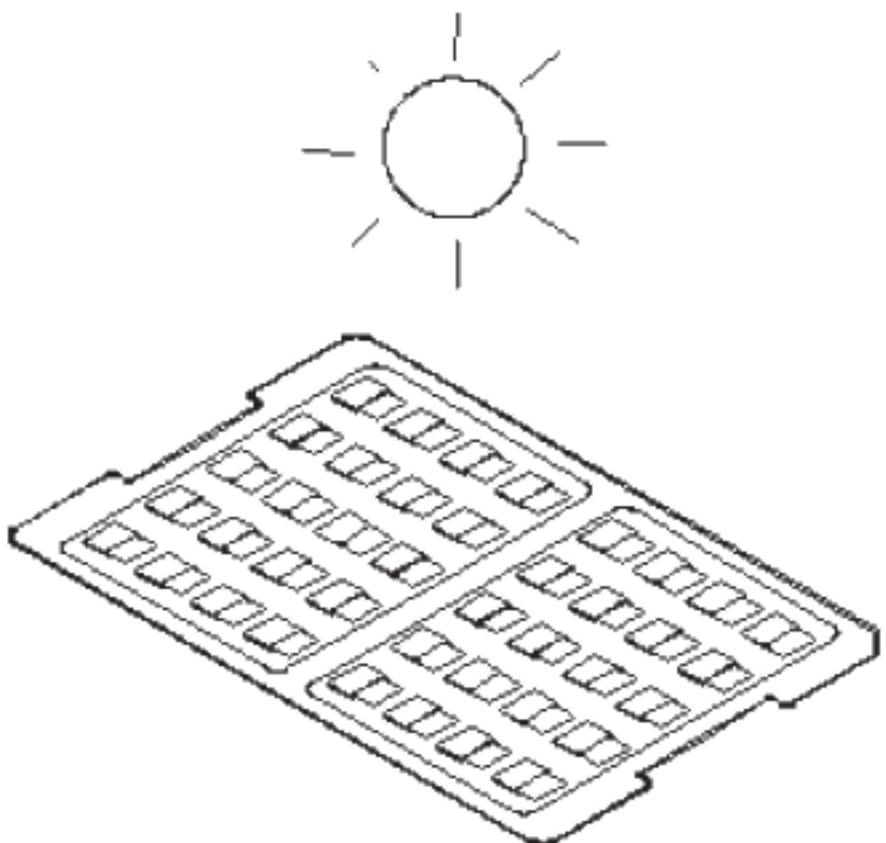
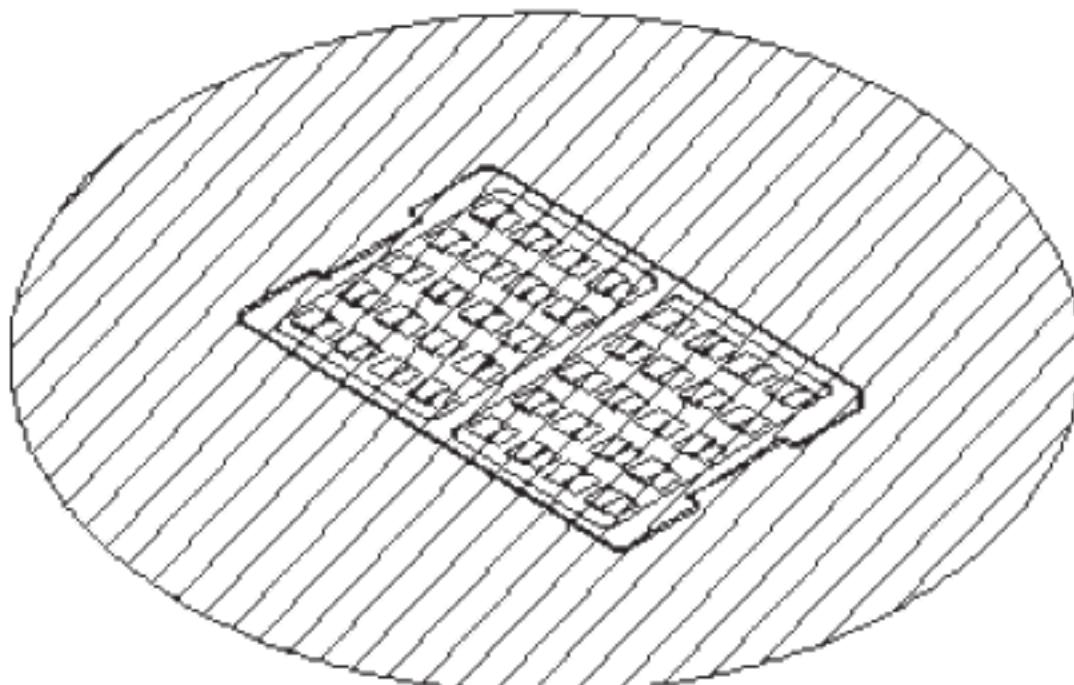
- (15) Do not touch the COG's patterning area. Otherwise the circuit may be damaged.
- (16) Do not touch LSI chips as it may cause a trouble in the inner lead connection.
- (17) Place a protective cover on the LCD module to protect the glass panel from mechanical damages.
- (18) LCD panel is susceptible to mechanical stress and even the slightest stress will cause a color change in background. So make sure the LCD panel is placed on flat plane without any continuous twisting, bending or pushing stress.
- (19) Protective film is placed onto the surface of LCD panel when it is shipped from factory. Make sure to peel it off before assembling the LCD module into the system. Be very careful not to damage LCD module by electrostatic discharge when peeling off this protective film. Ion blower and ground strap are recommended.
- (20) Make sure the mechanical design of the system in which the LCD module will be assembled matches specified viewing angle of this LCD module.
- (21) This LCD module does not contain nor use any ODS (1,1,1-Trichloroethane, CCL4) in all materials used, in all production processes.

[For operating LCD module]

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) At the shipment, adjust the contrast of each LCD module with electric volume. LCD contrast may vary from panel to panel depending on variation of LCD power voltage from system.
- (3) As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

[Precautions for Storage]

- (1) Do not expose the LCD module to direct sunlight or strong ultraviolet light for long periods. Store in a dark place.
- (2) The liquid crystal material will solidify if stored below the rated storage temperature and will become an isotropic liquid if stored above the rated storage temperature, and may not retain its original properties. Only store the module at normal temperature and humidity ($25\pm5^{\circ}\text{C}$, $60\pm10\%\text{RH}$) in order to avoid exposing the front polarizer to chronic humidity.
- (3) Keeping Method
 - a. Don't keeping under the direct sunlight.
 - b. Keeping in the tray under the dark place.

DON'T**DO**

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) Be sure to prevent light striking the chip surface.

[Other Notice]

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) As electrical impedance of power supply lines (VDDIO-GND) are low when LCD module is working, place the de-coupling capacitor nearby LCD module as close as possible.
- (3) Reset signal must be sent after power on to initialize LSI. LSI does not function properly until initialize it by reset signal.
- (4) Generally, at power on, in order not to apply DC charge directly to LCD panel, supply logic voltage first and initialize LSI logic function including polarity alternation. Then supply voltage for LCD bias. At power off, in order not to apply DC charge directly to LCD panel, execute Power OFF sequence and Discharge command.
- (5) Don't touch to FPC surface, exposed IC chip, electric parts and other parts, to any electric, metallic materials.
- (6) No bromide specific fire-retardant material is used in this module.
- (7) Do not display still picture on the display over 2 hours as this will damage the liquid crystal.
- (8) The connector used in this LCD module is the one Sharp have not ever used.
Therefore, please note that the quality of this connector concerned is out of Sharp's guarantee.
- (9) If the LCD module is kept under a high-humidity environment or it is used, the LCD module will curve.
Be fully careful about the keeping constraints and production-process environment of the LCD module.
- (10) When you connect the LCD module to your set, or when you remove, please turn OFF the power supply of your set.
- (11) When you bend FPC, please perform the straight radius more than uniform phi=0.6[mm].

[Precautions for Discarding Liquid Crystal Modules]

COG: After removing the LSI from the liquid crystal panel, dispose of it in a similar way to circuit boards from electronic devices.

LCD panel: Dispose of as glass waste. This LCD module contains no harmful substances. The liquid crystal panel contains no dangerous or harmful substances. The liquid crystal panel only contains an extremely small amount of liquid crystal (approx.100mg) and therefore it will not leak even if the panel should break.

-Its median lethal dose (LD50) is greater than 2,000 mg/kg and a mutagenetic (Aims test: negative) material is employed.

FPC: Dispose of as similar way to circuit board from electric device.

1. Application

This data sheet is to introduce the specification of LS055R1SX03 active matrix 16,777,216 color LCD module. Main color LCD module is controlled by Driver IC (R63419 with 1/3 RAM).

If any problem occurs concerning the items not stated in this specification, it must be solved sincerely by both parties after deliberation.

As to basic specification of driver IC refer to the IC specification and handbook.

2. Construction and Outline

Construction: LCD panel, Driver (COG), FPC with electric components,

14 White LED lumps, prism sheet, diffuser, light guide and reflector, plastic frame and PET Sheet to fix them mechanically.

Outline: See page 31page

Connection: B to B connector (Japan Aviation Electronics Industry, Ltd, WP7B-P050VA1 50 pins, 0.4mm pitch)
There shall be no scratches, stains, chips, distortions and other external drawbacks that may affect the display function.

Rejection criteria shall be noted in Inspection Standard (IIS-TBD)

In order to realize thin module structure, double-sided adhesive tapes are used to fix LCD panels. As these tapes do not guarantee to permanently fix the panels, LCD panel may rise from the module when shipped from factory.

So please make sure to design the system to hold the edges of LCD panel by the soft material such as sponge when LCD module is assembled into the cabinet.

3. Mechanical Specification

Table 1

| Item | Specifications | Unit | Remarks |
|---------------------|---------------------------------|--------|----------|
| Active area | 68.04(H)X120.96(V) | mm | |
| Pixel format | 1440(H)×2560(V) | Pixel | |
| | 1 Pixel =R+G+B dots | - | |
| Pixel pitch | 0.01575(H) x 0.04725(V) | mm | |
| Pixel configuration | R,G,B vertical stripes | - | |
| Display mode | Normally Black | - | |
| LDC Driving method | DC Driving / Column Inversion | - | |
| Liquid Crystal Mode | New Mode2 | - | |
| Number of colors | 16,777,216 | Colors | 24 bits |
| Outline dimensions | 70.94(W)×128.49 (H)×1.35(D) TYP | mm | Note 3-1 |
| Mass | Approx 25 | g | |

Note 3-1) The above-mentioned table indicates module sizes without some projections and FPC.

For detailed measurements and tolerances, please refer to page 31.

4. Absolute Maximum Ratings

(4-1) Electrical absolute maximum ratings

Table 2

Ta=25 °C

| Parameter | Symbol | Min | Max | Unit | Remark |
|----------------|-----------|------|------|------|--------|
| Supply Voltage | IOVCC-GND | -0.3 | +4.6 | V | *1 |
| | VSP-GND | -0.3 | +6.5 | V | *1 |
| | VSN-GND | -6.5 | +0.3 | V | *1 |

*1: Voltage applied to GND pins. GND pin conditions are based on all the same voltage (0V).

Always connect all GND externally and use at the same voltage.

Environment Conditions

Table 3

| Item | Top | | Tstg | | Remark |
|---------------------|---------|-------|---------|-------|-----------------|
| | MIN. | MAX. | MIN. | MAX. | |
| Ambient temperature | -20 °C | +60°C | -30 °C | +70°C | Note 2) |
| Humidity | Note 1) | | Note 1) | | No condensation |

Note1) Ta ≤ 40 °C.....95 % RH Max

Note2) Ta > 40 °C.....Absolute humidity shall be less than Ta=40 °C /95 % RH.

As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

Be sure not to exceed the rated voltage, otherwise a malfunction may occur.

5. Electrical Specifications

(5-1) Electrical characteristics

Table 4

Ta=25 °C, GND=0V

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit | Applicable Pin |
|---|-----------------|--------------|-----------|-------|-----------|------|-------------------------|
| Supply voltage1 | IOVCC-GND | Ta=-20~60 °C | 1.7 | 1.8 | 1.9 | V | (note 1) |
| Supply voltage2 | VSP-GND | Ta=-20~60 °C | 5.60 | 5.75 | 5.90 | V | (note 1) |
| Supply voltage3 | VSN-GND | Ta=-20~60 °C | -5.90 | -5.75 | -5.60 | V | (note 1) |
| "H" level input voltage | V _{IH} | Ta=-20~60 °C | 0.7 IOVCC | - | IOVCC | V | (note 2) |
| "L" level input voltage | V _{IL} | | 0 | - | 0.3IOVCC | V | |
| "H" level Input current | I _{IH} | Ta=-20~60 °C | - | - | 10 | μA | |
| "L" level Input current | I _{IL} | | -10 | - | - | μA | |
| "H" level Output voltage | V _{OH} | Ta=-20~60 °C | 0.8 IOVCC | - | IOVCC | V | I _{OH} =-0.1mA |
| "L" level Output voltage | V _{OL} | | - | - | 0.2 IOVCC | V | I _{OL} =+0.1mA |
| MIPI high speed mode | | | | | | | |
| Common mode voltage High Speed receive mode | VCMRX(DC) | Ta=-20~60 °C | 70 | | 330 | mV | (note 3) |
| Differential input high threshold voltage | VIDTH | Ta=-20~60 °C | - | - | 70 | mV | (Note 3) |
| Differential input low threshold voltage | VIDTL | Ta=-20~60 °C | -70 | - | - | mV | (Note 3) |
| Single-ended input high voltage | VIHHS | Ta=-20~60 °C | - | - | 460 | mV | (Note 3) |
| Single-ended input low voltage | VILHS | Ta=-20~60 °C | -40 | - | - | mV | (Note 3) |
| MIPI LP mode | | | | | | | |
| Logic High level input voltage | VIH | Ta=-20~60 °C | 880 | | 1350 | mV | (Note 3) |
| Logic Low level input voltage | VIL | Ta=-20~60 °C | -50 | | 550 | mV | (Note 3) |
| Logic High level output voltage | VOH | Ta=-20~60 °C | 1.1 | 1.2 | 1.3 | V | (Note 3) |
| Logic Low level output voltage | VOL | Ta=-20~60 °C | -50 | | 50 | mV | (Note 3) |
| Logic 0 contention threshold | VILCD | Ta=-20~60 °C | - | - | 200 | mV | (Note 3) |
| Logic 1 contention threshold | VIHCD | Ta=-20~60 °C | 450 | - | - | mV | (Note 3) |
| A Current consumption | Iiovcc1 | Ta=25 °C | - | 23.5 | 32.9 | mA | (note 4) |
| | Ivsp1 | Ta=25 °C | - | 15 | 21 | mA | (note 4) |
| | Ivsn1 | Ta=25 °C | - | 14 | 19.6 | mA | (note 4) |

(Note 1) Include Ripple Noise

(Note 2) Applied overshoot

(Note 3) VCMRX(DC)=(VP+VDN)/2;

Minimum 110mV/-110mV HS differential swing is required for display data transfer.

(Note 4) Measurement conditions: Ta=25°C Full screen white pattern, VSP=5.75V/VSN=-5.75V/IOVCC=1.8V, 60HZ Refresh

(5-2) LED back light

(1) At main panel the back light uses 14pcs edge light type white LED.



Table 5

| Parameter | Conditions | Symbol | Min. | Typ. | Max. | Unit | Remark |
|-----------------|-----------------------|------------------|------|------|------|------|-----------------------|
| Forward current | T _A =25 °C | I _{LED} | - | 20*1 | - | mA | LEDA LEDC1-/LEDC2- |

LED lamp: NSSW304D (NICHIA)

*1 per one piece of LED

*Please consider Allowable Forward Current on used temperature
(refer to Ambient Temperature vs. Allowable Forward Current curve)

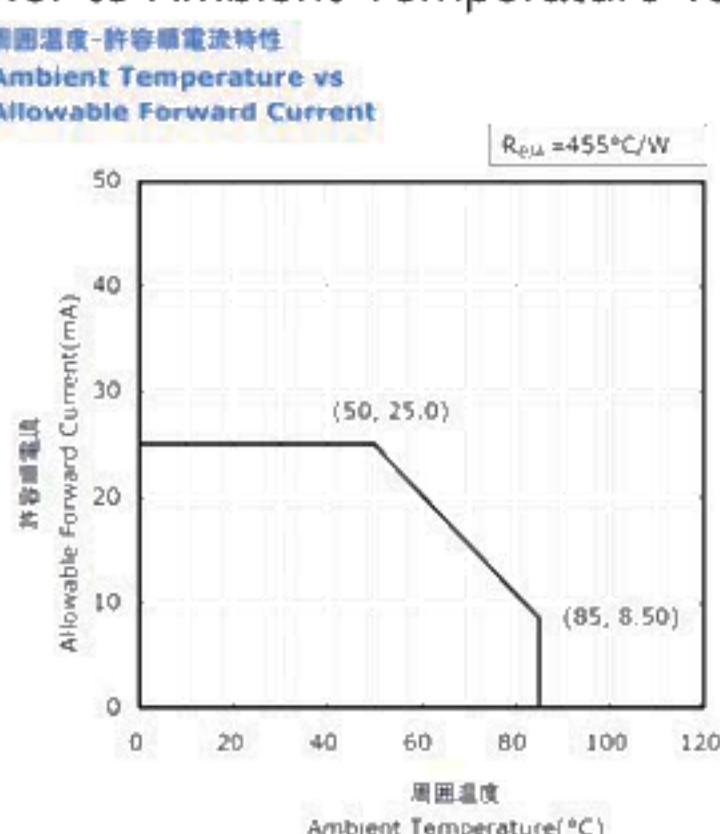


Fig.1 LED Characteristic(De-rating Curve)

(1) Absolute Maximum Ratings

| Item | Symbol | Absolute Maximum Rating | Unit |
|-----------------------|------------------|-------------------------|------|
| Forward Current | I _F | 25 | mA |
| Pulse Forward Current | I _{FP} | 80 | mA |
| Reverse Voltage | V _R | 5 | V |
| Power Dissipation | P _D | 82.5 | mW |
| Operating Temperature | T _{opr} | -30~85 | °C |
| Storage Temperature | T _{stg} | -40~100 | °C |
| Junction Temperature | T _J | 105 | °C |

* Absolute Maximum Ratings at T_A=25°C.* I_{FP} conditions with pulse width ≤10ms and duty cycle ≤10%.

(2) Initial Electrical/Optical Characteristics

| Item | Symbol | Condition | Typ | Max | Unit |
|--|------------------|----------------------|--|----------------|--------|
| Forward Voltage | V _F | I _F =20mA | 3.0 | - | V |
| Reverse Current | I _R | V _R =5V | - | - | μA |
| Luminous Flux (Chromaticity Coordinate1) | Φ _v | I _F =20mA | 8.0 | - | lm |
| Luminous Intensity (Chromaticity Coordinate1) | I _v | I _F =20mA | 2.55 | - | cd |
| Chromaticity Coordinate1 | x y | - | I _F =20mA I _F =20mA | 0.300 0.295 | - - |
| Luminous Flux (Chromaticity Coordinate2) | Φ _v | I _F =20mA | 7.65 | - | lm |
| Luminous Intensity (Chromaticity Coordinate2) | I _v | I _F =20mA | 2.4 | - | cd |
| Chromaticity Coordinate2 | x y | - | I _F =20mA I _F =20mA | 0.290 0.275 | - - |
| Thermal Resistance | R _{θJS} | - | 120 | 180 | °C/W |

* Characteristics at T_A=25°C.

* Luminous Flux value as per CIE 127:2007 standard.

* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

* R_{θJS} is Thermal Resistance from junction to T_S measuring point.

(5-3) Interface signals

Table 6

| Pin No | Symbol | Description | I/O | Remarks |
|--------|------------|--|-----|------------|
| 1 | GND | Ground | - | |
| 2 | DSI_A_D3- | MIPI DS(-) of Port A | I | |
| 3 | DSI_A_D3+ | MIPI DS(+) of Port A | I | |
| 4 | GND | Ground | - | |
| 5 | DSI_A_CLK- | MIPI DS Clock (-) of PortA | I | |
| 6 | DSI_A_CLK+ | MIPI DS Clock (+) of PortA | I | |
| 7 | GND | Ground | - | |
| 8 | DSI_A_D2- | MIPI DS (-) of PortA | I | |
| 9 | DSI_A_D2+ | MIPI DS (+) of PortA | I | |
| 10 | GND | Ground | - | |
| 11 | DSI_B_D1+ | MIPI DS (+) of PortB | I | |
| 12 | DSI_B_D1- | MIPI DS (-) of PortB | I | |
| 13 | GND | Ground | - | |
| 14 | DSI_B_D0+ | MIPI DS (+) of PortB | I/O | |
| 15 | DSI_B_D0- | MIPI DS (-) of PortB | I/O | |
| 16 | GND | Ground | - | |
| 17 | VSP | Power supply for analog(+5.75V) | - | |
| 18 | VSN | Power supply for analog(-5.75V) | - | |
| 19 | GND | Ground | - | |
| 20 | LED1- | LED back light power negative1 (group1) | | |
| 21 | LED2- | LED back light power negative1 (group2) | | |
| 22 | LEDK3(NC) | No connect | - | |
| 23 | LEDK4(NC) | No connect | - | |
| 24 | LED+ | LED back light power positive | - | |
| 25 | LED+ | LED back light power positive | - | |
| 26 | GND | Ground | - | |
| 27 | MTP(NC) | No connect | - | |
| 28 | IOVCC | Power supply for I/O | - | |
| 29 | RESX | Device reset signal | I | "L" Active |
| 30 | IM(GND) | Ground | - | |
| 31 | LED_PWM | Control signal for brightness of LED backlight | O | |
| 32 | TE | Tearing signal output from driver IC | O | |
| 33 | H SYNC | Horizontal Synchronizing signal | O | |
| 34 | ID1 | ID1(connect to GND1 in FPC) | - | |
| 35 | GND | Ground | - | |
| 36 | DSI_B_D3- | MIPI DS (-) of PortB | I | |
| 37 | DSI_B_D3+ | MIPI DS (+) of PortB | I | |
| 38 | GND | Ground | - | |
| 39 | DSI_B_CLK- | MIPI DS Clock (-) of PortB | I | |
| 40 | DSI_B_CLK+ | MIPI DS Clock (+) of PortB | I | |
| 41 | GND | Ground | - | |
| 42 | DSI_B_D2- | MIPI DS (-) of PortB | I | |
| 43 | DSI_B_D2+ | MIPI DS (+) of PortB | I | |
| 44 | GND | Ground | - | |
| 45 | DSI_A_D1+ | MIPI DS (+) of PortA | I | |
| 46 | DSI_A_D1- | MIPI DS (-) of PortA | I | |
| 47 | GND | Ground | - | |
| 48 | DSI_A_D0+ | MIPI DS(+) of Port A | I/O | |
| 49 | DSI_A_D0- | MIPI DS(-) of Port A | I/O | |
| 50 | GND | Ground | - | |

Mounted connector : 50pins; 0.4mm pitch; B to B connector. (JAE : WP7B-P050VA1)

Corresponded connector : 50pins; 0.4mm pitch; B to B connector. (JAE : WP7B-S050VA1)

Signals connect to LCD module. Symbols correspond able to Circuit diagram in Page 11.

(5-4) Schematic of LCD module system

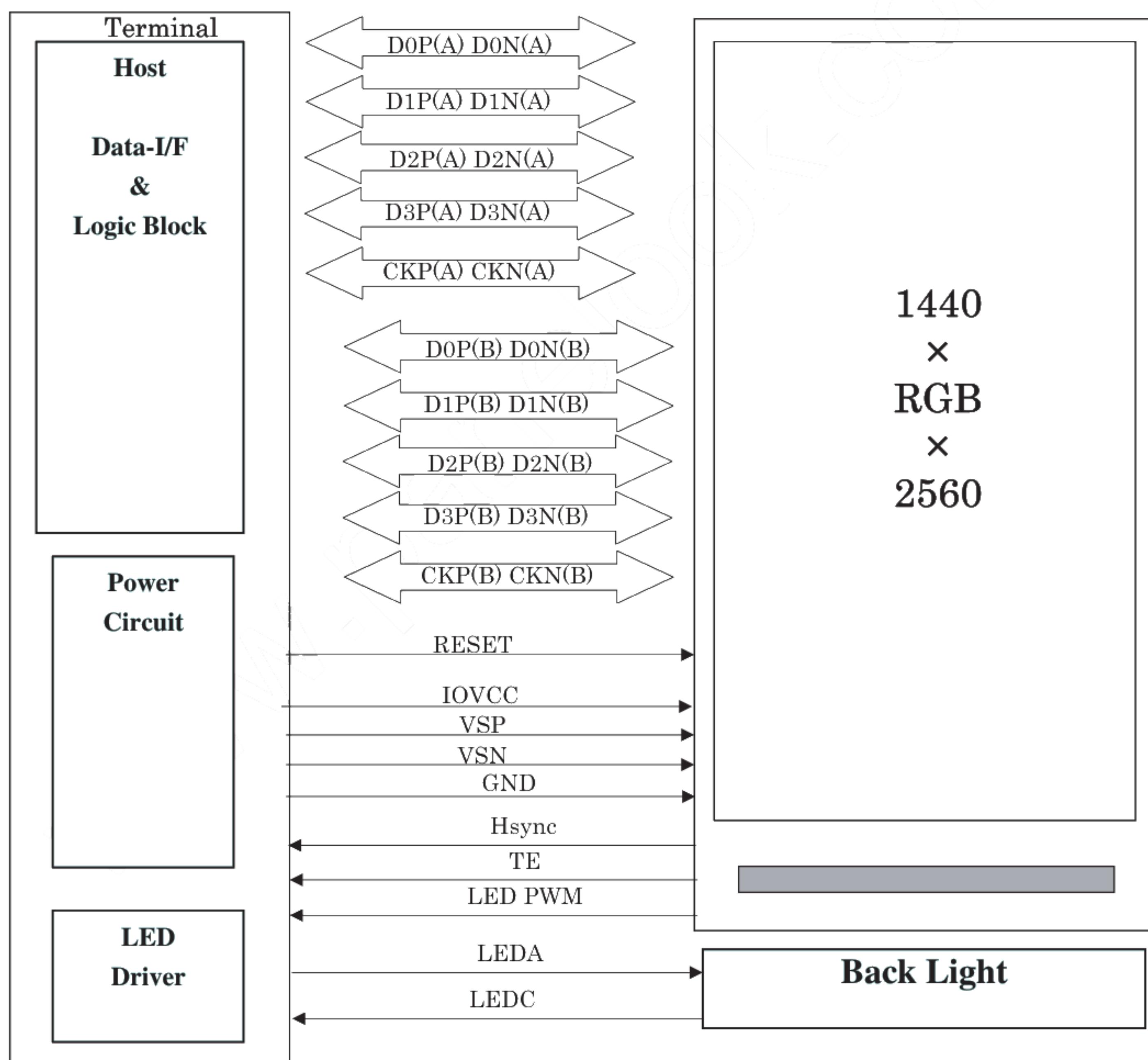


Fig.2 Schematic of LCD module system

(5-5) Circuit Diagrams

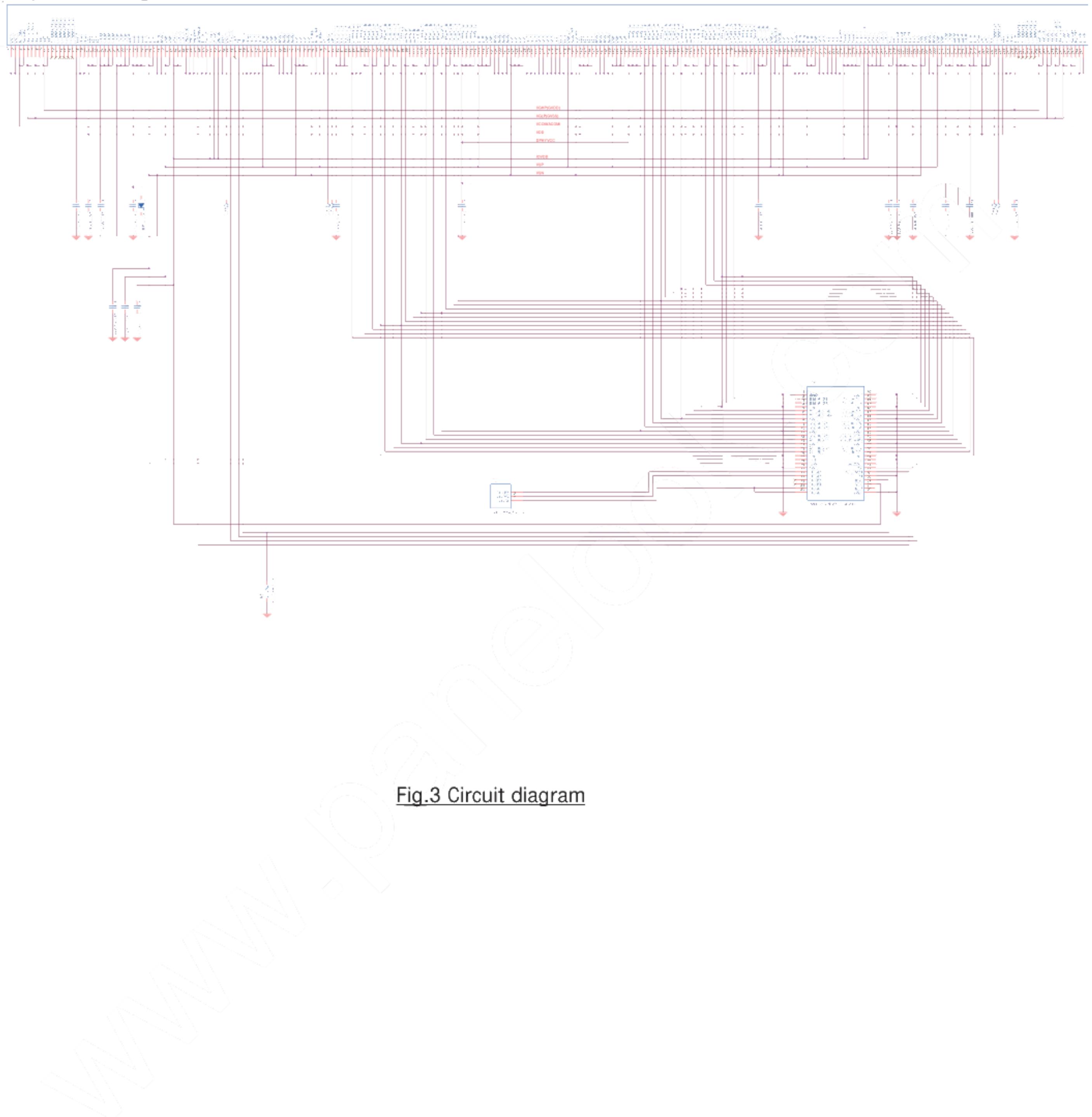


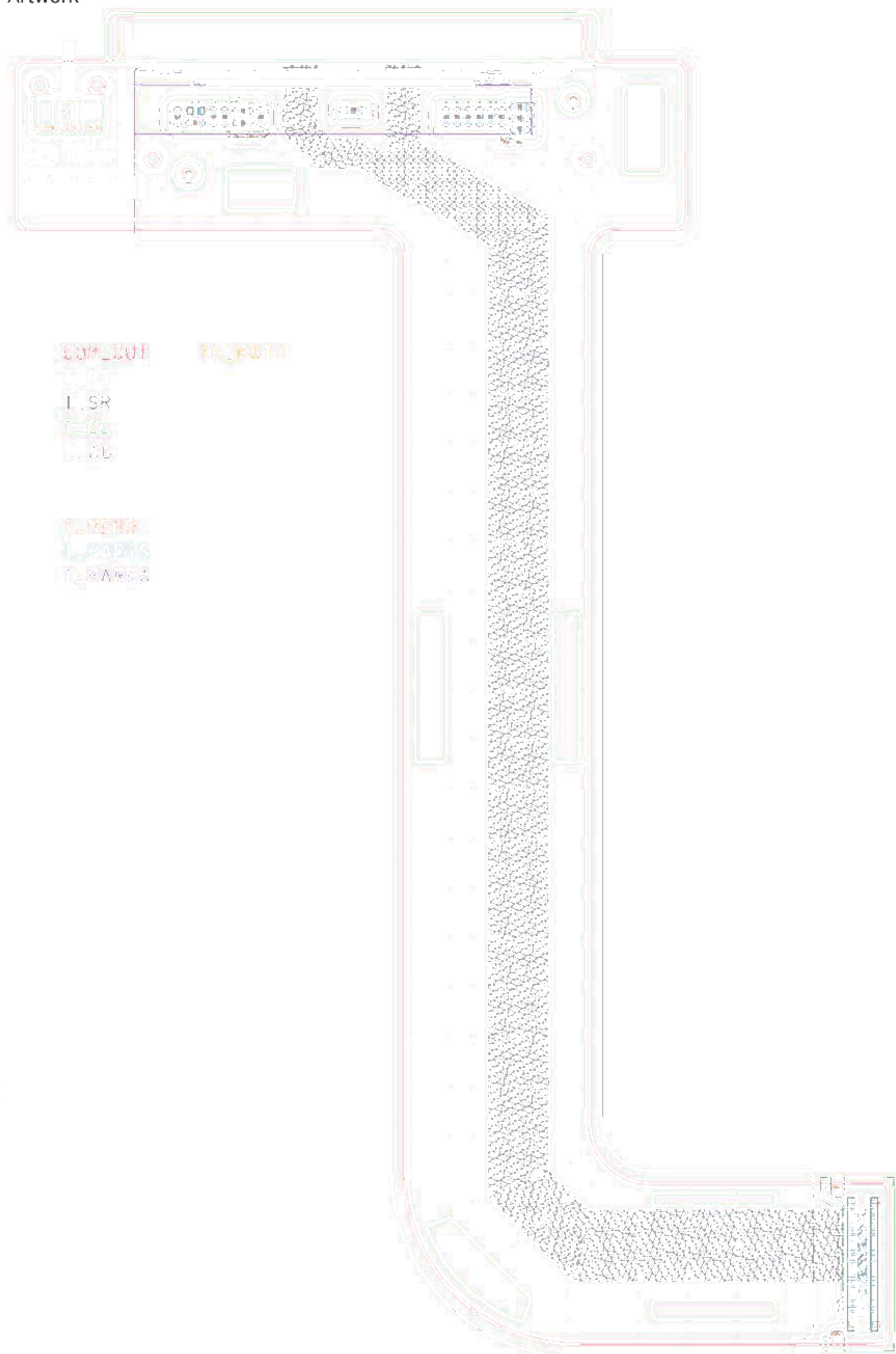
Fig.3 Circuit diagram

(5-6) Parts List

Table 7

| Category | Ref. No. | Spec | | | Vendor |
|-----------|----------|---------------------|------|------|--------------|
| Capacitor | C1 | 2.2uF | 16V | 1005 | Multi Vendor |
| | C2 | 2.2uF | 6.3V | 1005 | Multi Vendor |
| | C3 | 1.0uF | 25V | 1005 | Multi Vendor |
| | C4 | 2.2uF | 16V | 1005 | Multi Vendor |
| | C5 | 1.0uF | 6.3V | 1005 | Multi Vendor |
| | C7 | 1.0uF | 6.3V | 1005 | Multi Vendor |
| | C8 | 2.2uF | 6.3V | 1005 | Multi Vendor |
| | C9 | 2.2uF | 6.3V | 1005 | Multi Vendor |
| | C10 | 1.0uF | 6.3V | 1005 | Multi Vendor |
| | C11 | 1.0uF | 25V | 1005 | Multi Vendor |
| | C12 | 2.2uF | 16V | 1005 | Multi Vendor |
| | C13 | 2.2uF | 16V | 1005 | Multi Vendor |
| | C14 | 2.2uF | 10V | 1005 | Multi Vendor |
| | C15 | 2.2uF | 10V | 1005 | Multi Vendor |
| | C16 | 2.2uF | 6.3V | 1005 | Multi Vendor |
| Resister | R1 | 100kOhm/1005/0.063W | | | Multi Vendor |
| Diode | D1 | VF<0.4V VR≥max.25V | | | ROHM |
| Connector | CN | 0.4mm pitch / 50Pin | | | JAE |

(5-7)FPC Artwork

Fig. 4 Layer 1

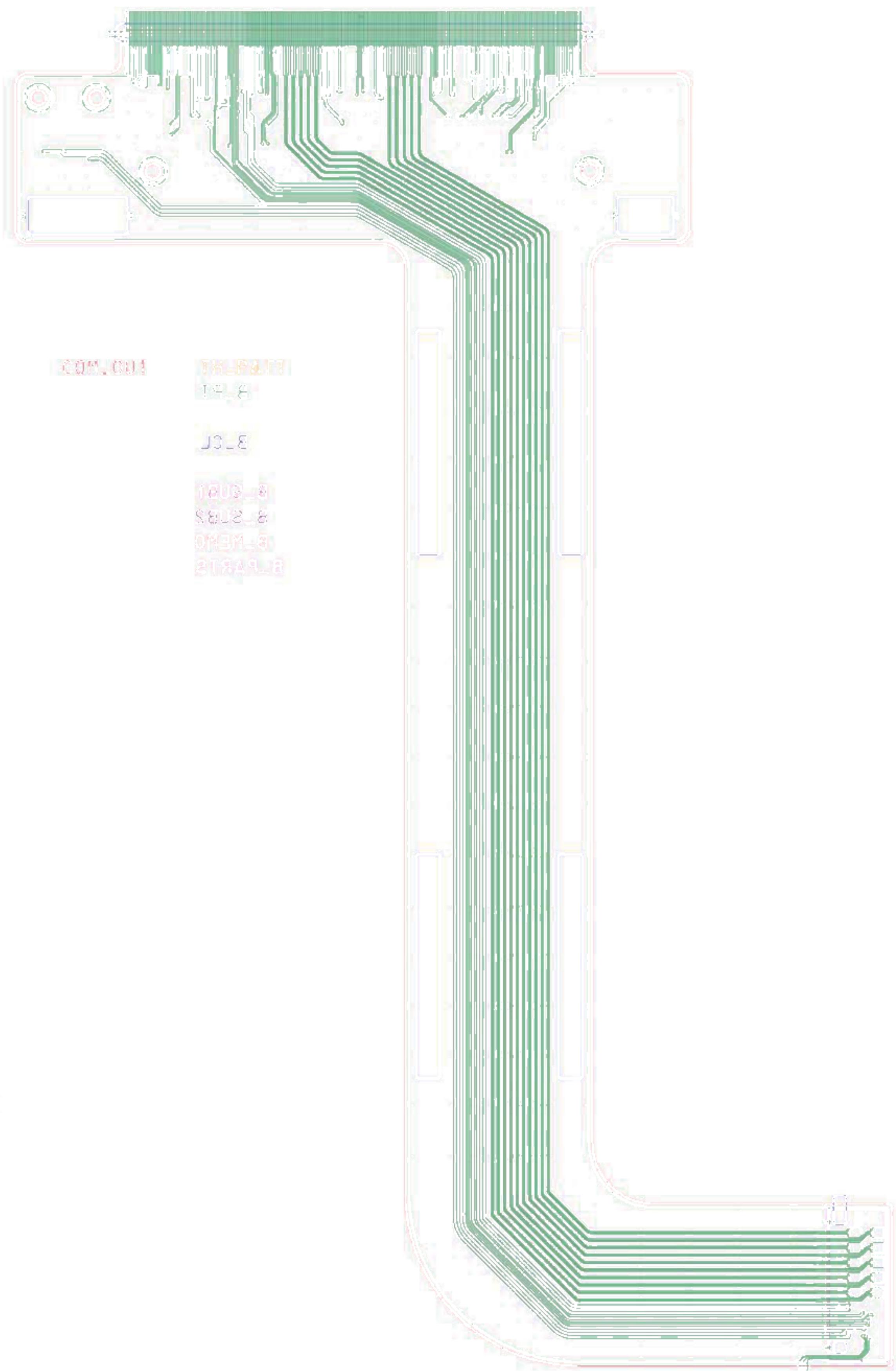


Fig. 5 Layer 2

6. Timing characteristics of input signals

(6-1)MIPI DC/AC Characteristics

<DC characteristics>

Table 8

Ta=+25°C, GND=0V

| Item | Symbol | Unit | Test condition | Min. | Typ. | Max. | Note |
|-------|--|-----------|----------------|----------------------|------|------|-------|
| HS-RX | Differential input high threshold | VIDTH | mV | IOVDD= 1.65V~3.30V | - | - | 70 2 |
| | Differential input low threshold | VIDTL | mV | IOVDD= 1.65V~3.30V | -70 | - | - 2 |
| | Single-ended input low voltage | VILHS | mV | IOVDD= 1.65V~3.30V | -40 | - | - |
| | Single-ended input high voltage | VIHHS | mV | IOVDD= 1.65V~3.30V | - | - | 460 |
| | Common-mode voltage HS receive mode | VCMRX(DC) | mV | IOVDD= 1.65V~3.30V | 70 | - | 330 1 |
| | Differential input impedance | ZID | Ω | IOVDD= 1.65V~3.30V | - | 100 | - |
| LP-RX | Logic 0 input voltage not in ULP State | VIL | mV | IOVDD= 1.65V~3.30V | -50 | - | 550 |
| | Logic 1 input voltage | VIH | mV | IOVDD= 1.65V~3.30V | 880 | - | 1350 |
| | I/O leakage current | ILEAK | µA | Vin = -50mV - 1350mV | -10 | - | 10 |
| LP-TX | Thevenin output low level | VOL | mV | IOVDD= 1.65V~3.30V | -50 | - | 50 |
| | Thevenin output high level | VOH | V | IOVDD= 1.65V~3.30V | 1.1 | 1.2 | 1.3 |
| | Output impedance of LP transmitter | ZOLP | Ω | IOVDD=1.80V | 110 | - | - |
| CD-RX | Logic 0 contention threshold | VILCD | mV | IOVDD= 1.65V~3.30V | - | - | 200 |
| | Logic 1 contention threshold | VIHCD | mV | IOVDD= 1.65V~3.30V | 450 | - | - |

Notes: 1. VCMRX (DC) = (VP+VDN)/2

2. Minimum 110mV/110mV HS differential swing is required for display data transfer.

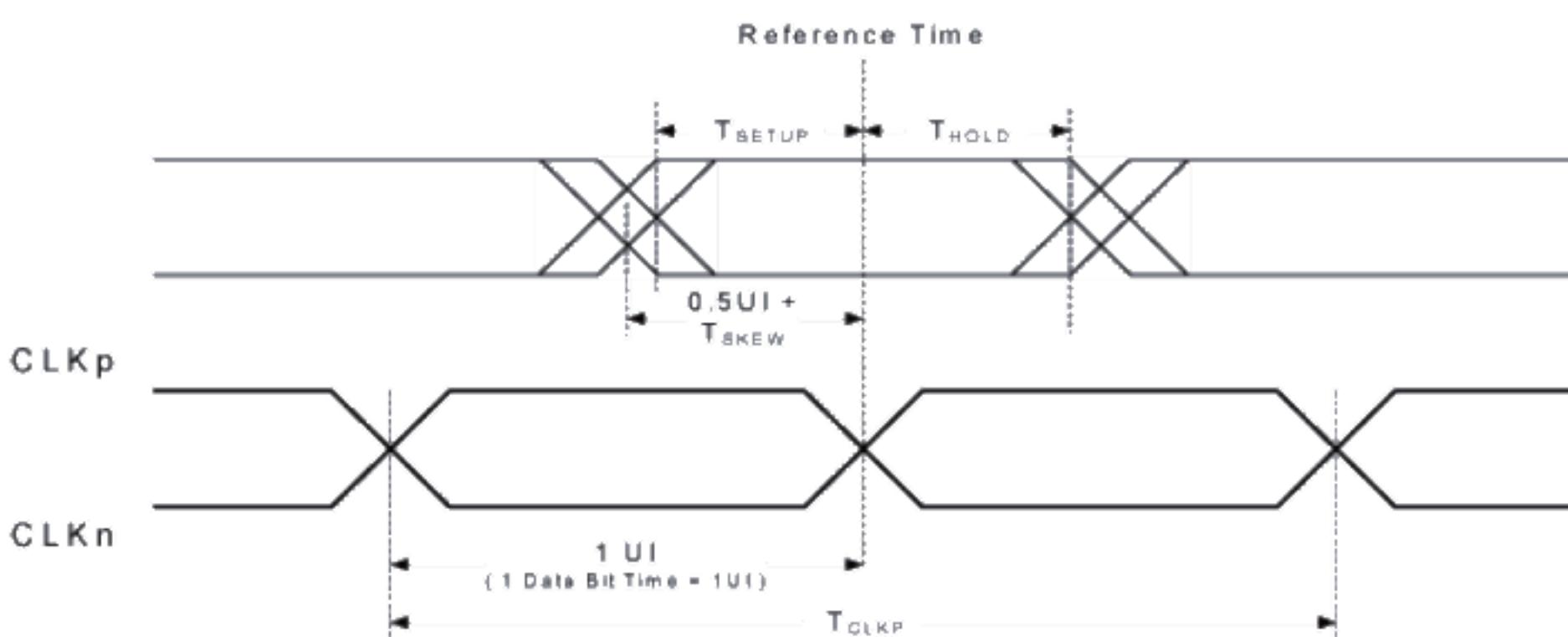
<AC Characteristics>

Table 9

Ta=+25°C, GND=0V

| Item | Symbol | Unit | Test condition | Min. | Typ. | Max. | Note |
|--------------------------|---------|------|--|------|------|------|------|
| DSICLK Frequency | fDSICLK | MHz | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V | 100 | - | 500 | 1 |
| DSICLK Cycle time | tCLKP | ns | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V | 1 | - | 10 | |
| DSI Data Transfer Rate | tDSIR | Mbps | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V DSI 2 lanes, 3 lanes, 4 lane | 200 | - | 1000 | 1 |
| Data to Clock Setup Time | tSETUP | UI | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V | 0.15 | - | - | 3 |
| | | ns | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V | 0.15 | - | - | 2,3 |
| Clock to Data Hold Time | tHOLD | UI | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V | 0.15 | - | - | 3 |
| | | ns | IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V | 0.15 | - | - | 2,3 |

- Notes:
1. When fDSICLK<125MHz, change auto load NV setting so that it is compliant with THS-PREPARE+THS-ZERO spec.
 2. Minimum tSETUP/tHOLD Time is 0.15UI. This value may change according to DSI transfer rate.
 3. tSETUP/tHOLD Time are measured without HS-TX Jitter.



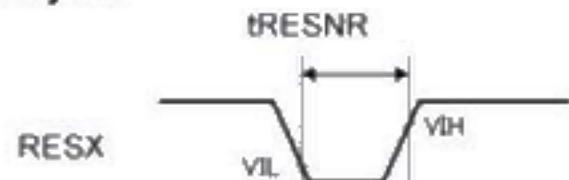
(6-2) Reset Timing Characteristics

Table 10

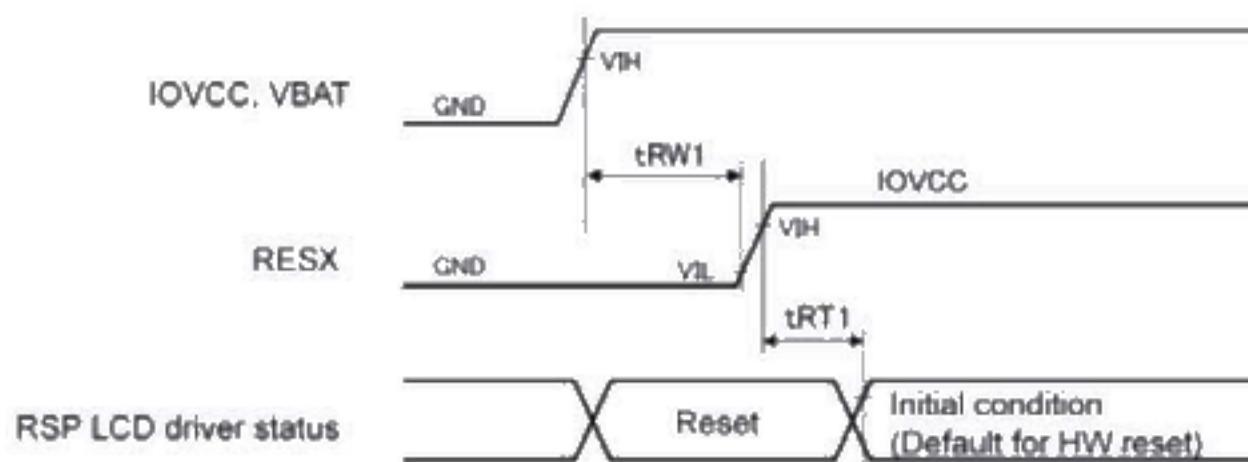
Ta=+25°C, GND=0V

| Item | Symbol | Unit | Test condition | Min. | Max. |
|------------------------|--------|------|-----------------|------|------|
| Reset low-level width1 | tRW1 | us | Power supply on | 1000 | — |
| Reset low-level width2 | tRW2 | us | Operation | 1000 | — |
| Reset time (Sleep IN) | tRT1 | ms | — | — | 3 |
| Reset time (Sleep OUT) | tRT2 | ms | — | — | 3 |
| Noise reject width | tRESNR | us | — | — | 1 |

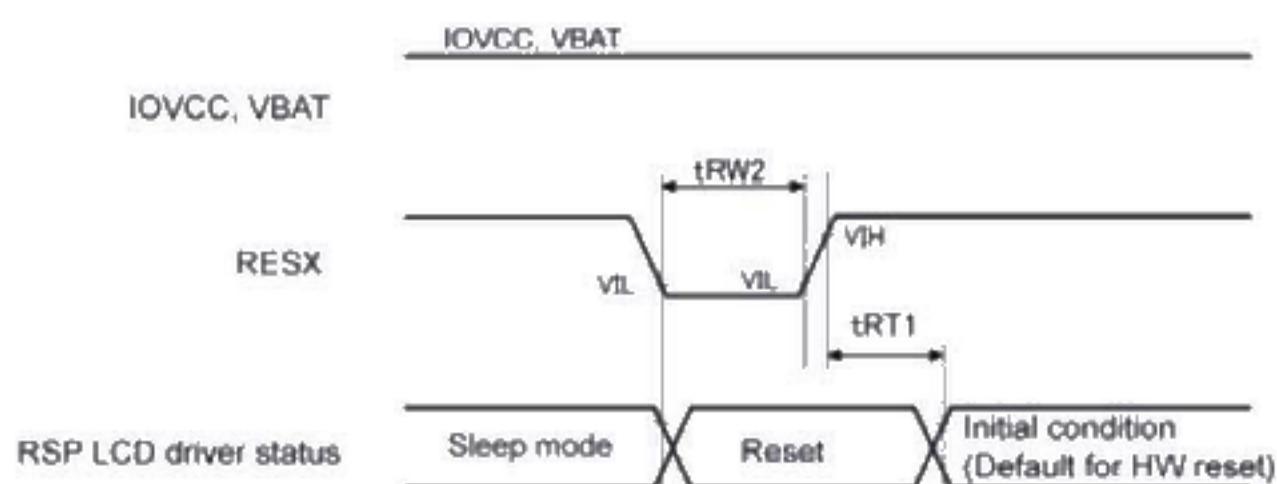
(1) Reset Reject



(2-a) Reset timing at power supply on



(2-b) Reset timing during operation (sleep in)



(2-c) Reset timing during operation (sleep out)

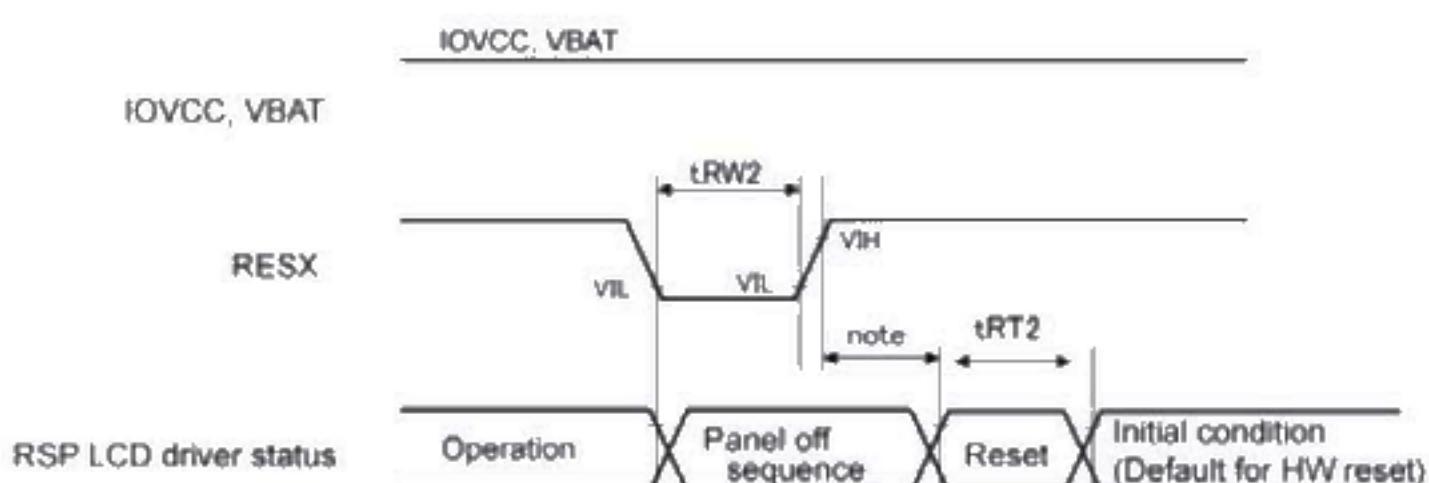
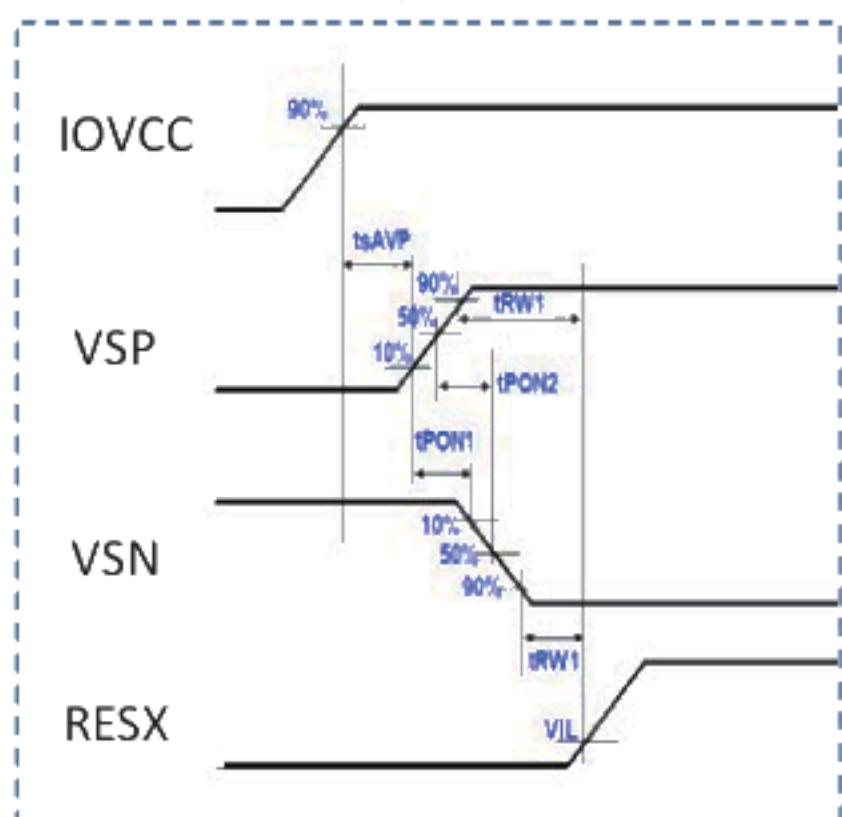
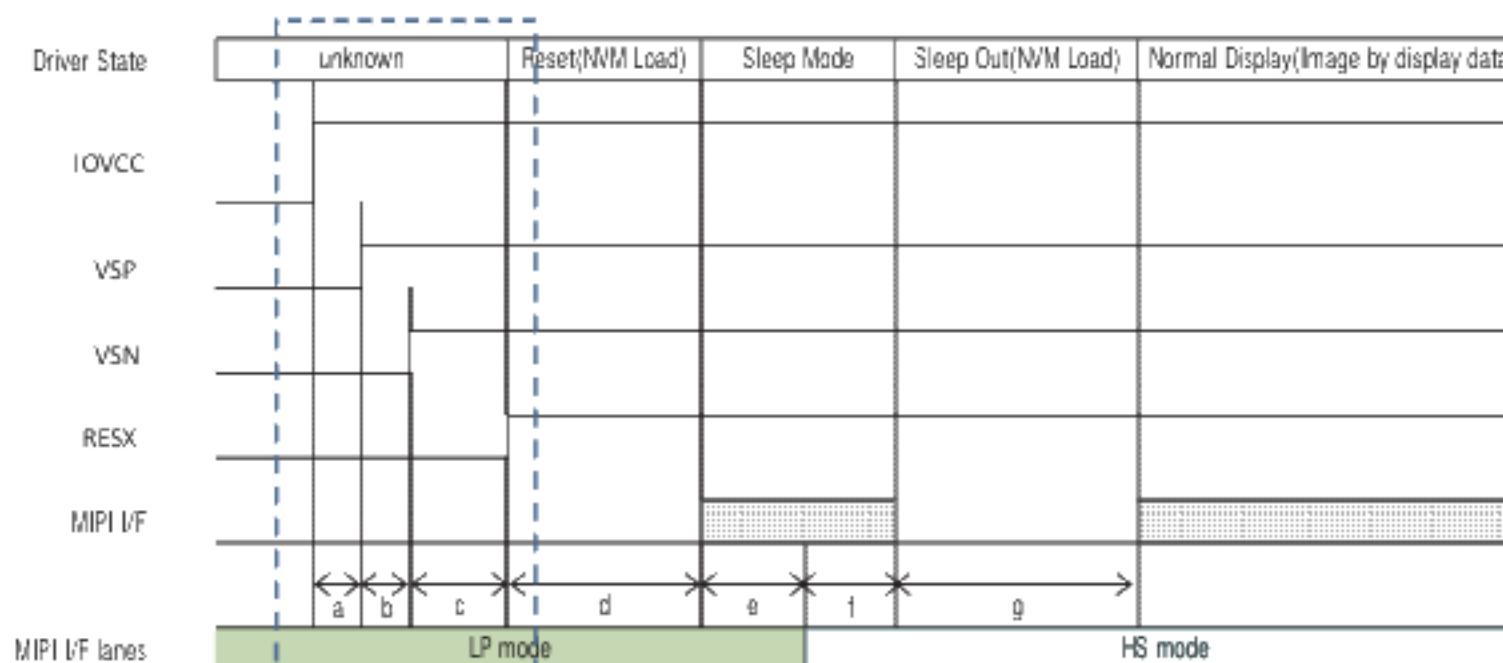


Fig .6 Reset timing characteristics

7. Initial Sequence

(7-1) Power On Sequence (command mode)



| Item | Symbol | min |
|------------------------------------|--------|-----|
| VSP to VSN delay time (10% to 10%) | tPON1 | 0ms |
| VSP to VSN delay time (50% to 50%) | tPON2 | 0ms |
| System power on to VSP ON time | tsAVP | 1ms |
| Reset low-level width | tRW1 | 1ms |

200ms

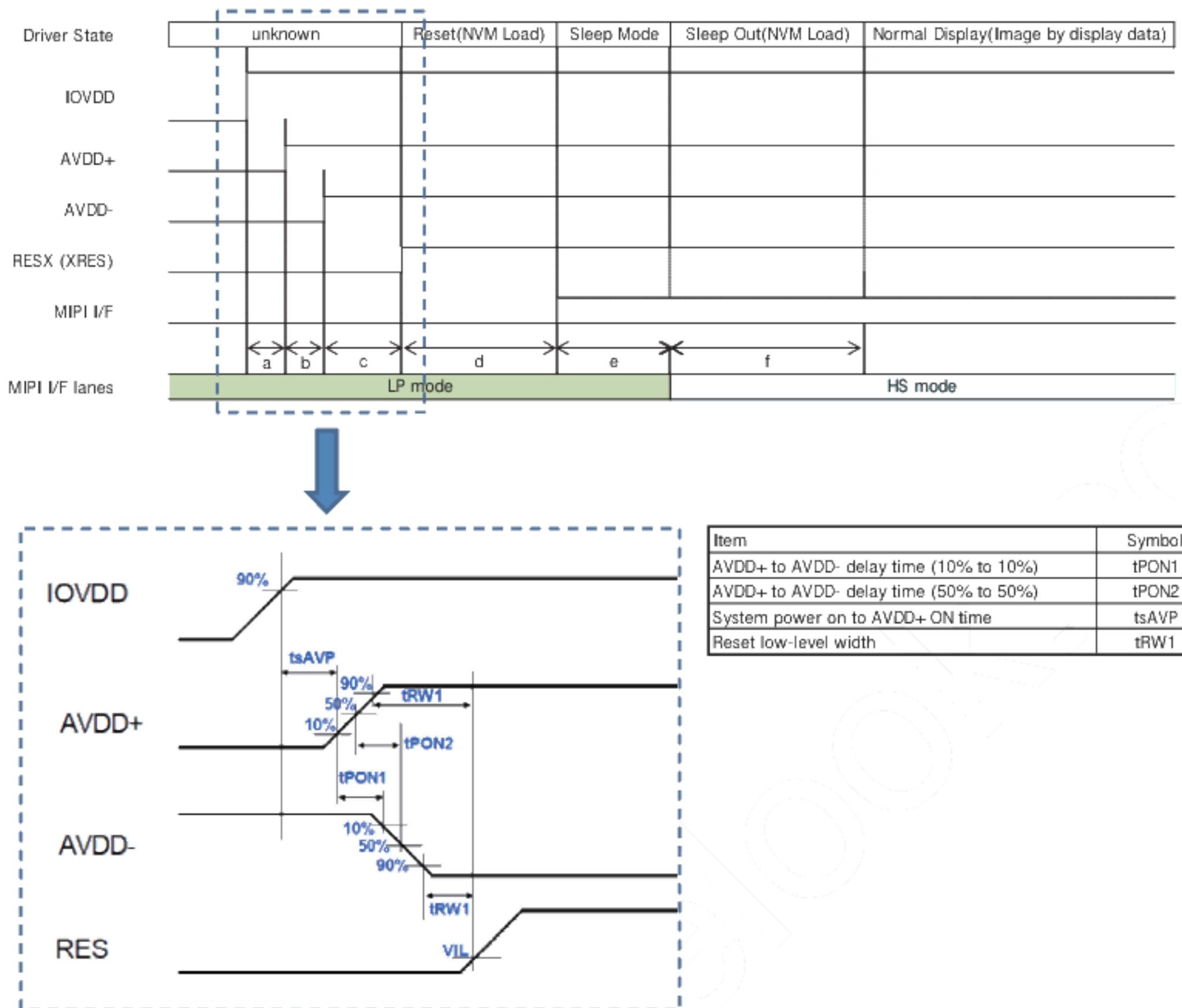


<Command mode>

| Recommended Power On Sequence | | | | | | | term |
|-------------------------------|---|-----------|------|---------------|-------------|---|------|
| Step | Address | Parameter | Data | DSI data type | Delay | Command | |
| 1 | Initial condition | | | | | RESX = L | |
| 2 | Power Supply IOVCC (Typ1.8V) | | | | | IOVCC ON | |
| 3 | Wait | | | | tsAVP | Wait until power stable | a. |
| 4 | Power Supply VSP (Typ5.75V) | | | | | VSP ON | |
| 5 | Wait | | | | tPON1/tPON2 | | b. |
| 6 | Power Supply VSN (Typ-5.75V) | | | | | VSN ON | |
| 7 | Wait | | | | tRW1 | | c. |
| 8 | RESET High | | | | | RESX = H | |
| 9 | Wait | | | | Min.10 ms | [Automatic] NVM Auto load | d. |
| 10 | | | | | | [Automatic] Sleep Mode On | |
| 11 | 0xB0 | P1 | 00h | Generic | 29h | The command to unlock manufacturing command write (CABC, CE etc.) | |
| | 0xD6 | P1 | 01h | Generic | 29h | The command to remove NVM reload after sleep out. | |
| | 0xB3 | P1 | 08h | Generic | 29h | MIPI Command mode=08h | |
| | 0x51 | P1 | FFh | DCS | 39h | Display Brightness = 100% | |
| | 0x53 | P1 | 0Ch | DCS | 39h | LED PWM output enable / Dimming function ON | |
| | 0x35 | P1 | 00h | DCS | 39h | TE enable | |
| | 0x2A | P1 | 00h | DCS | 39h | start Column address : 000h | |
| | | P2 | 00h | | | end Column address : 59Fh (1439) | |
| | | P3 | 05h | | | | |
| | | P4 | 9Fh | | | | |
| | If customer need, please add initial command in here. | | | | | | |
| 12 | 0xB0 | P1 | 03h | Generic | 29h | The command to lock manufacturing command write | |
| 13 | Display data transfer | - | - | DCS | 39h | Image Write | |
| 14 | 0x29 | - | - | DCS | 39h | Display On | |
| 15 | 0x11 | - | - | DCS | 39h | Sleep Out | |
| 16 | Wait | | | | Min.6 frame | | |
| | | | | | | [Automatic] Sleep Mode Off/Display On | g. |

Table 11-1

(7-2) Power On Sequence (Video mode)

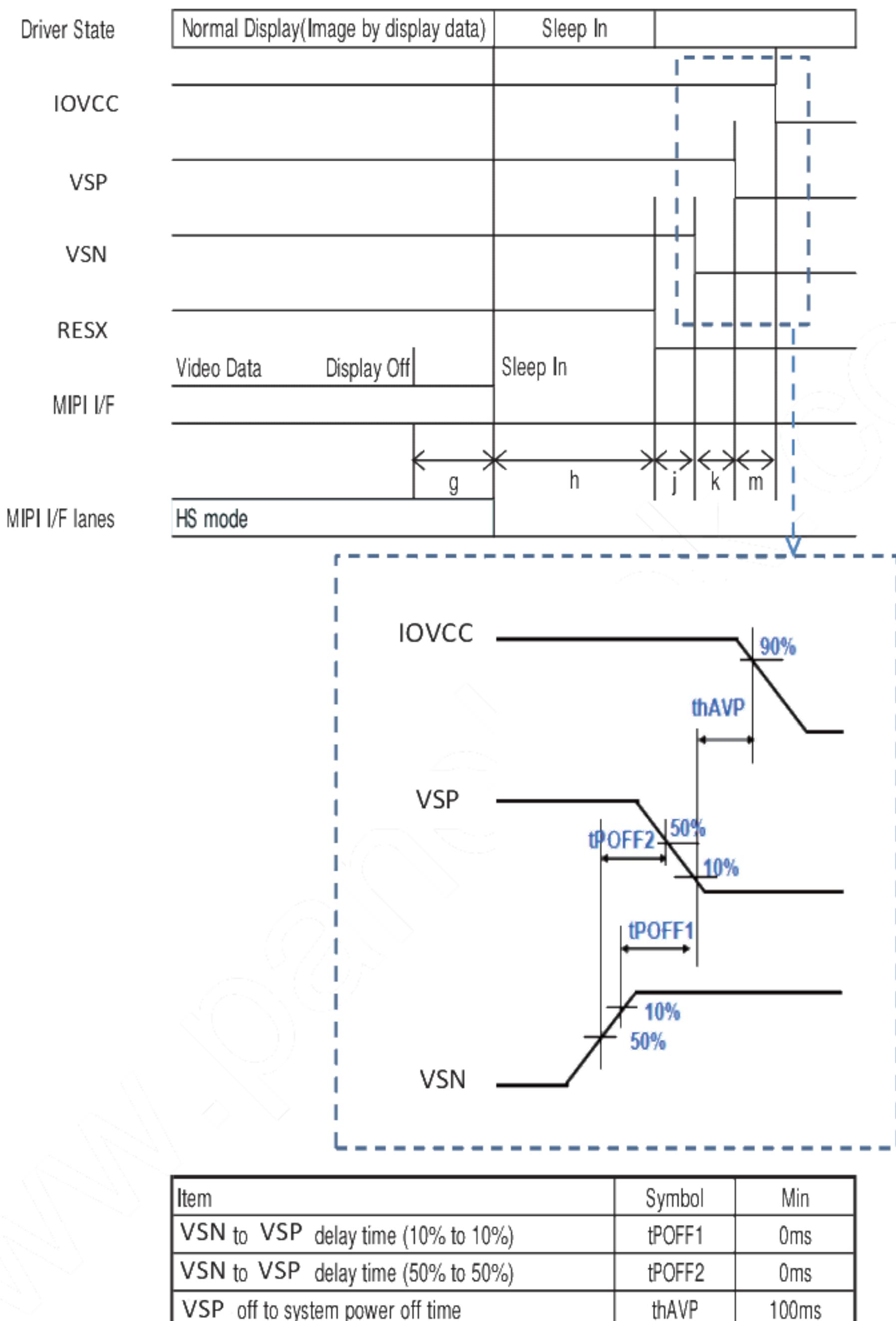


<Video mode>

| Recommended Power On Sequence | | | | | | | term |
|-------------------------------|---|-----------|------|---------------|-------------|---|------|
| Step | Address | Parameter | Data | DSI data type | Delay | Command | |
| 1 | Initial condition | | | | | XRES = L | |
| 2 | Power Supply IOVDD (Typ1.8V) | | | | | IOVDD ON | |
| 3 | Wait | | | | tsAVP | Wait until power stable | a. |
| 4 | Power Supply AVDD+ (Typ5.75V) | | | | | AVDD+ ON | |
| 5 | Wait | | | | tPON1/tPON2 | | b. |
| 6 | Power Supply AVDD- (Typ-5.75V) | | | | | AVDD- ON | |
| 7 | Wait | | | | tRW1 | | c. |
| 8 | RESX High | | | | | XRES = H | |
| 9 | Wait | | | | Min.10 ms | [Automatic] NVM Auto load | d. |
| 10 | | | | | | [Automatic] Sleep Mode On | |
| 11 | 0xB0 | P1 | 00h | Generic | 29h | The command to unlock manufacturing command write (CABC, CE etc.) | e. |
| | 0xD6 | P1 | 01h | Generic | 29h | The command to remove NVM reload after sleep out. | |
| | 0xB3 | P1 | 18h | Generic | 29h | MIPI Video through mode=18h | |
| | 0x51 | P1 | FFh | DCS | 39h | Display Brightness = 100% | |
| | 0x53 | P1 | 0Ch | DCS | 39h | LED PWM output enable / Dimming function ON | |
| | 0x35 | P1 | 00h | DCS | 39h | TE enable | |
| | If customer need, please add initial command in here. | | | | | | |
| 12 | 0xB0 | P1 | 03h | Generic | 29h | The command to lock manufacturing command write | f. |
| 13 | 0x29 | - | - | DCS | 39h | Display On | |
| 14 | 0x11 | - | - | DCS | 39h | Sleep Out | |
| 15 | Host Display Data transfer | | | | Min.6 frame | Image Write(Send Video Stream Packet) | |
| 16 | Wait | | | | | [Automatic] Sleep Mode Off/Display On | |

Table 11-2

(7-3) Power Off Sequence(Command mode)

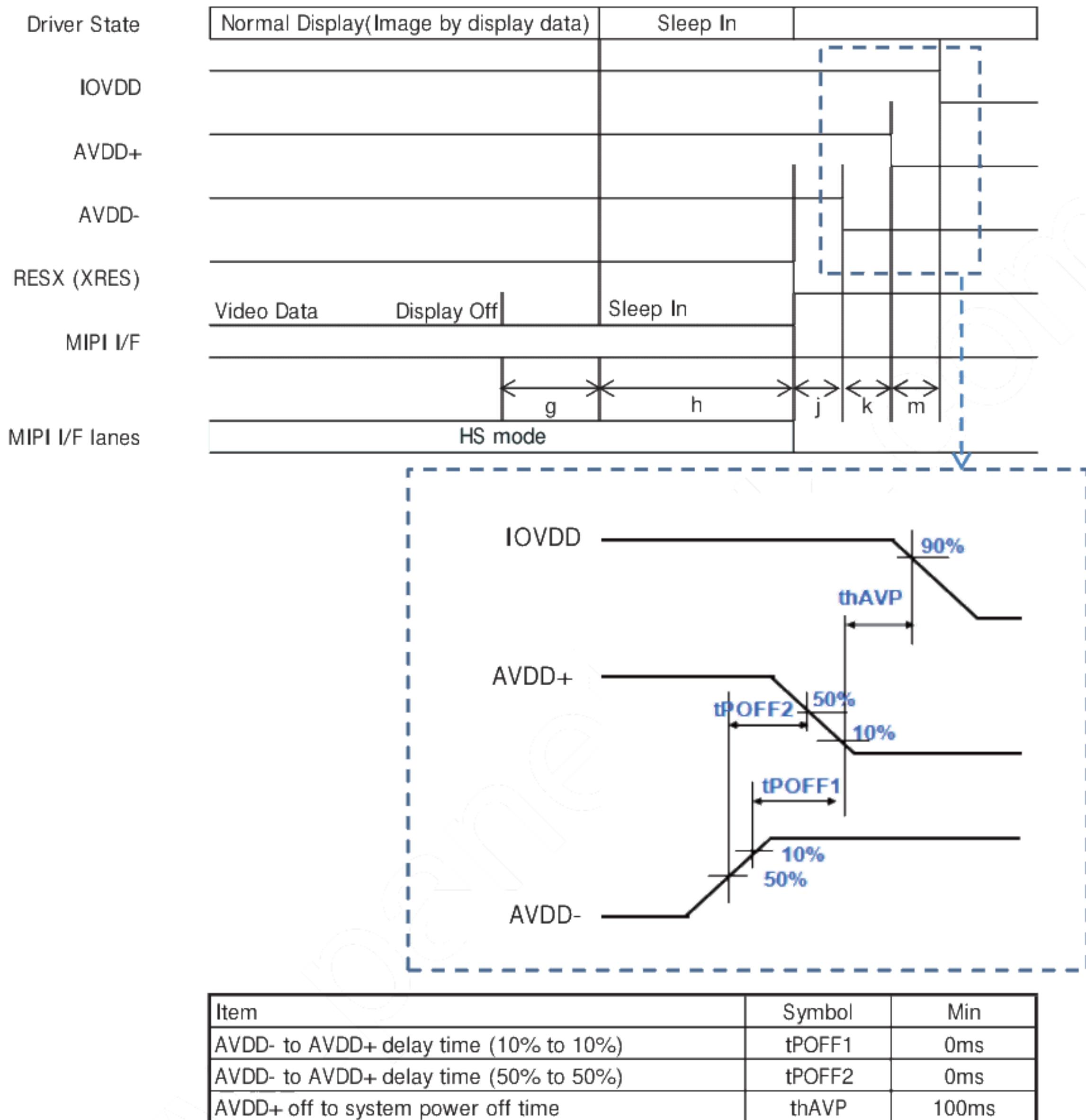


<Command mode>

| Recommended Power Off Sequence | | | | | | |
|--------------------------------|------------------------|-----------|------|---------------|---------------|----------|
| Step | Address | Parameter | Data | DSI data type | Delay | Command |
| 1 | 28h | - | - | DCS | 39h | |
| 2 | Wait | | | | Min.1 frame | |
| 3 | 10h | - | - | DCS | 39h | |
| 4 | Wait | | | | Min. 4frame | |
| 5 | RESET Low | | | | | RESX = L |
| 6 | Wait | | | | Min.0ms | |
| 7 | VSN(Typ-5.75V) OFF | | | | | |
| 8 | | | | | tPOFF1/tPOFF2 | Wait |
| 9 | VSP(Typ+5.75V) OFF | | | | | |
| 10 | | | | | thAVP | Wait |
| 11 | IOVCC OFF(Typ1.8V) OFF | | | | | |

Table 12-1

(7-4) Power Off Sequence(Video mode)



<Video mode>

| Step | Address | Parameter | Data | Recommended Power Off Sequence | | | term |
|------|------------------------|-----------|------|--------------------------------|---------------|---|------|
| | | | | DSI data type | Delay | Command | |
| 1 | 28h | - | - | DCS | 39h | | |
| 2 | Wait | | | | Min.1 frame | | g |
| 3 | 10h | - | - | DCS | 39h | | |
| 4 | Wait | | | | Min. 4frame | Hsync/Vsync signals should be send after Sleep In command | h |
| 5 | | | | | | Mipi data transfer Stop | |
| 6 | RESX Low | | | | | XRES = L | |
| 7 | Wait | | | | Min.0ms | | j |
| 8 | AVDD-(Typ-5.75V) OFF | | | | tPOFF1/tPOFF2 | Wait | k |
| 9 | | | | | thAVP | Wait | |
| 10 | AVDD+(Typ+5.75V) OFF | | | | | | |
| 11 | | | | | | | m |
| 12 | IOVDD OFF(Typ1.8V) OFF | | | | | | |

Table 12-2

8. Mipi Video Setting

Condition

- DSI 4Lane, 2port
- 850Mbps/Lane

Vertical Display Timing

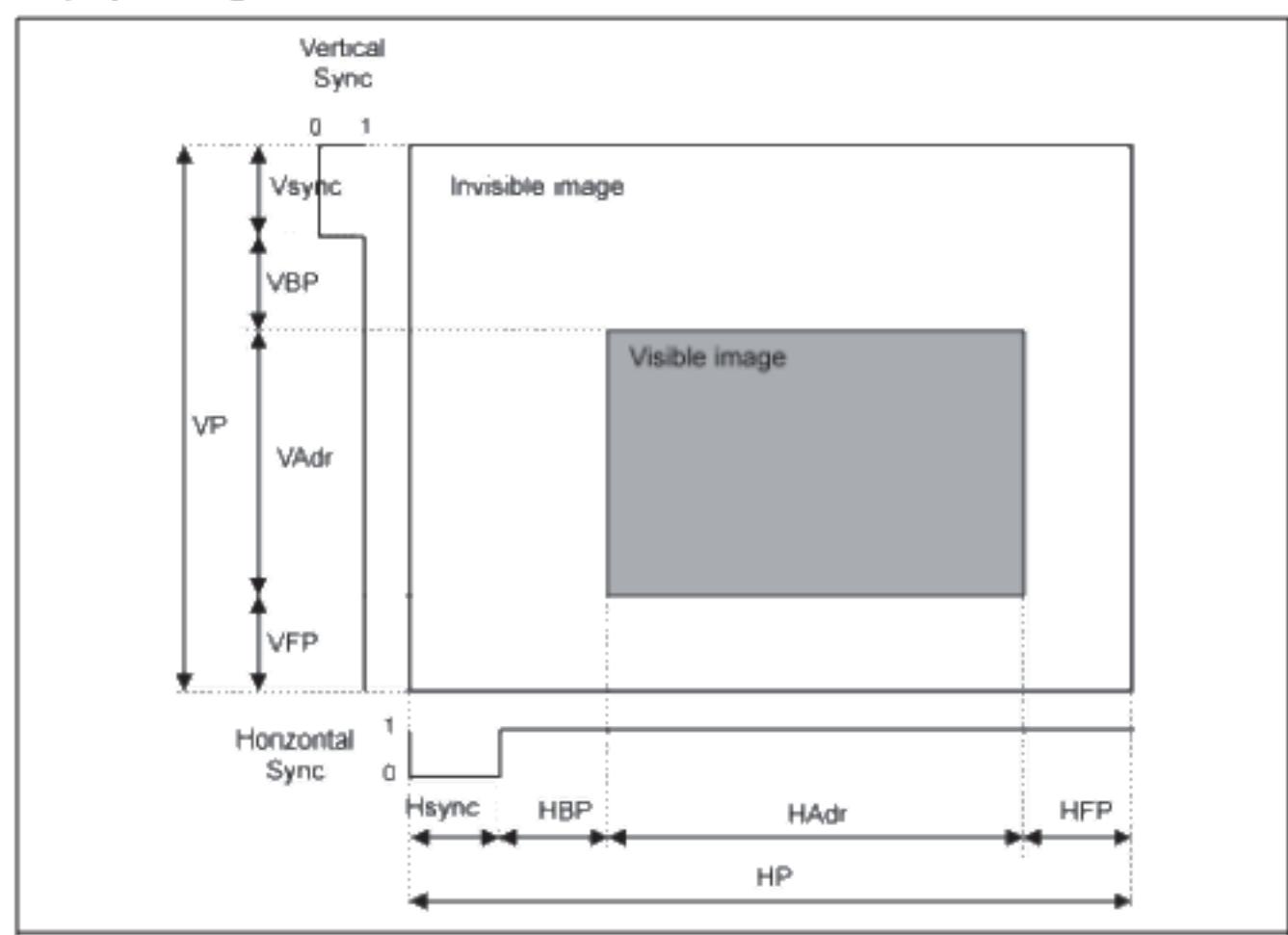
| Item | Symbol | Condition | Unit | Value |
|---------------------------|--------|-----------|------|-------|
| Vertical cycle | VP | | Line | 2568 |
| Vertical low pulse width | VS | | Line | 1 |
| Vertical front porch | VFP | | Line | 4 |
| Vertical back porch | VBP | | Line | 3 |
| Vertical data start point | - | BP | Line | 4 |
| vertical blanking period | VBL | VFP+BP | Line | 8 |
| Vertical active area | Vadr | | Line | 2560 |

Horizontal Display Timing

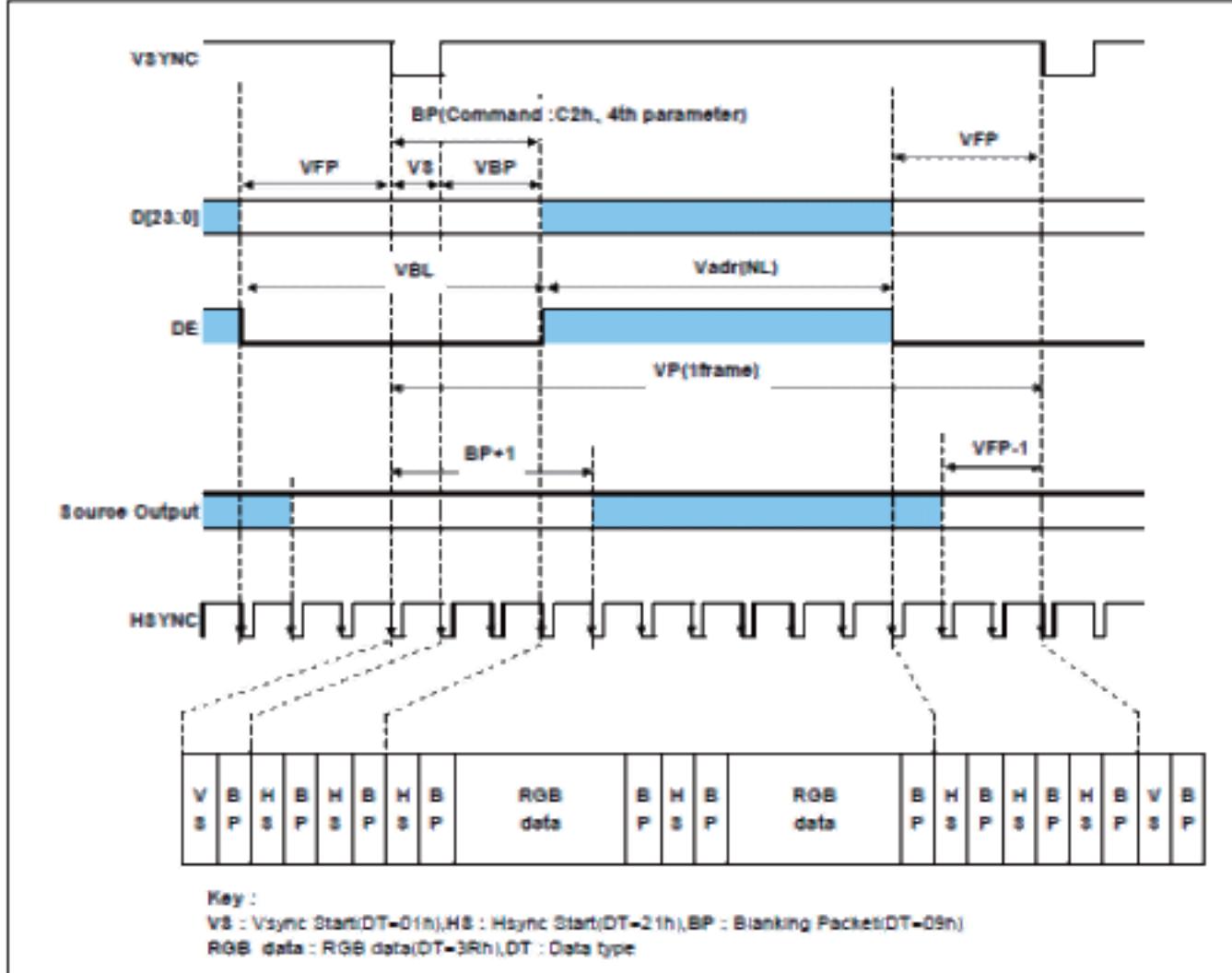
| Item | Symbol | Condition | Unit | Value |
|-----------------------------|--------|-----------|-----------|-------|
| Horizontal front porch | HFP | | ByteClock | 100 |
| Horizontal data start point | - | HS+HBP | ByteClock | 46 |
| Horizontal active area | Hadr | | Pixel | 1440 |

Frame Frequency:60.3Hz

Display Timing



Vertical Display Timing



Horizontal Display Timing

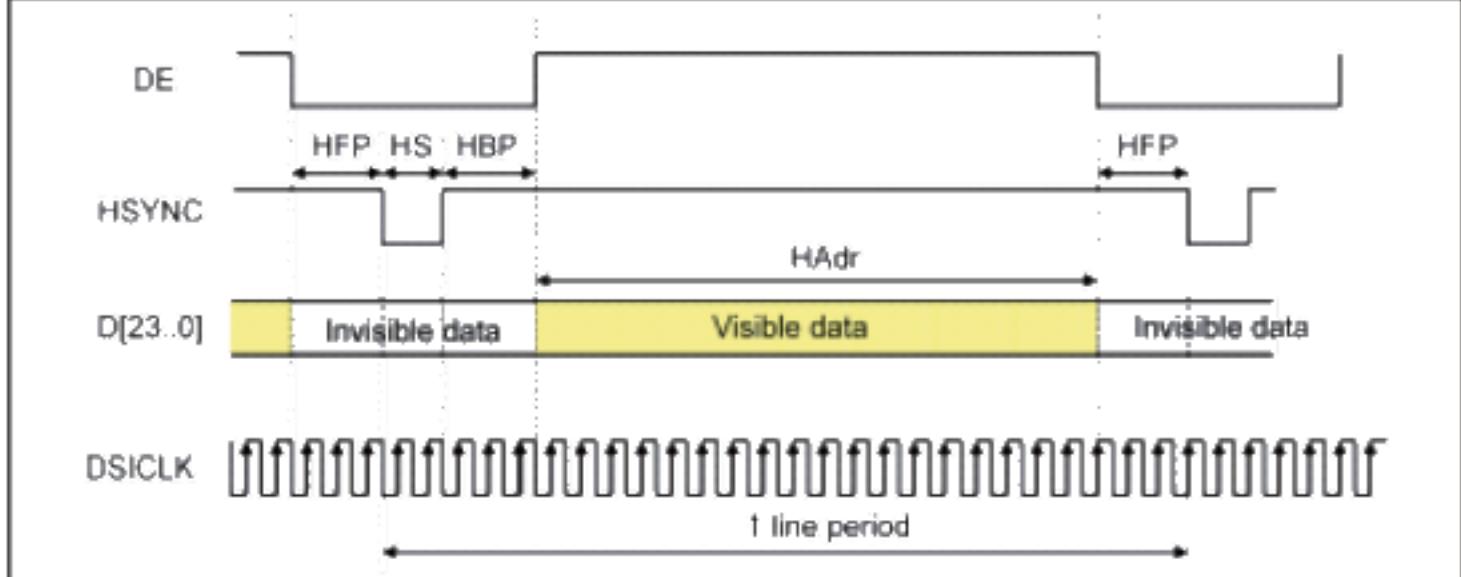


Table 13

9. Optical Characteristics

Table 14

IOVCC=1.8V, VSP=5.75V, VSN=-5.75V, ILED=20mA/pcs, Ta = 25°C

| Optical Characteristics | | | | | | | |
|-------------------------|--------|-----------|------|------|------|-------------------|----------|
| Parameter | symbol | condition | MIN | TYP | MAX | unit | Remark |
| Brightness | Br | θ=0° | 315 | 450 | - | cd/m ² | Note1,2 |
| Response Time | Tr +Td | θ=0° | | - | 35 | ms | Note5 |
| Contrast | Co | θ=0° | 900 | 1300 | - | | Note1,3 |
| Viewing Angle | θ11 | Co > 10 | 70 | 80 | - | deg | Note1 |
| | θ12 | | 70 | 80 | - | | |
| | θ21 | | 70 | 80 | - | | |
| | θ22 | | 70 | 80 | - | | |
| White chromaticity | x | θ=0° | 0.27 | 0.30 | 0.33 | | Note.1,3 |
| | y | | 0.29 | 0.32 | 0.35 | | |
| Red chromaticity | x | θ=0° | 0.62 | 0.65 | 0.68 | | |
| | y | | 0.31 | 0.34 | 0.37 | | |
| Green chromaticity | x | θ=0° | 0.28 | 0.31 | 0.34 | | |
| | y | | 0.58 | 0.61 | 0.64 | | |
| Blue chromaticity | x | θ=0° | 0.13 | 0.16 | 0.19 | | |
| | y | | 0.04 | 0.07 | 0.10 | | |
| Uniformity | - | θ=0° | 70 | - | - | % | Note.4 |
| NTSC ratio | - | θ=0° | | 70 | - | % | Note.1,3 |

Note 1) Definition of range of visual angle

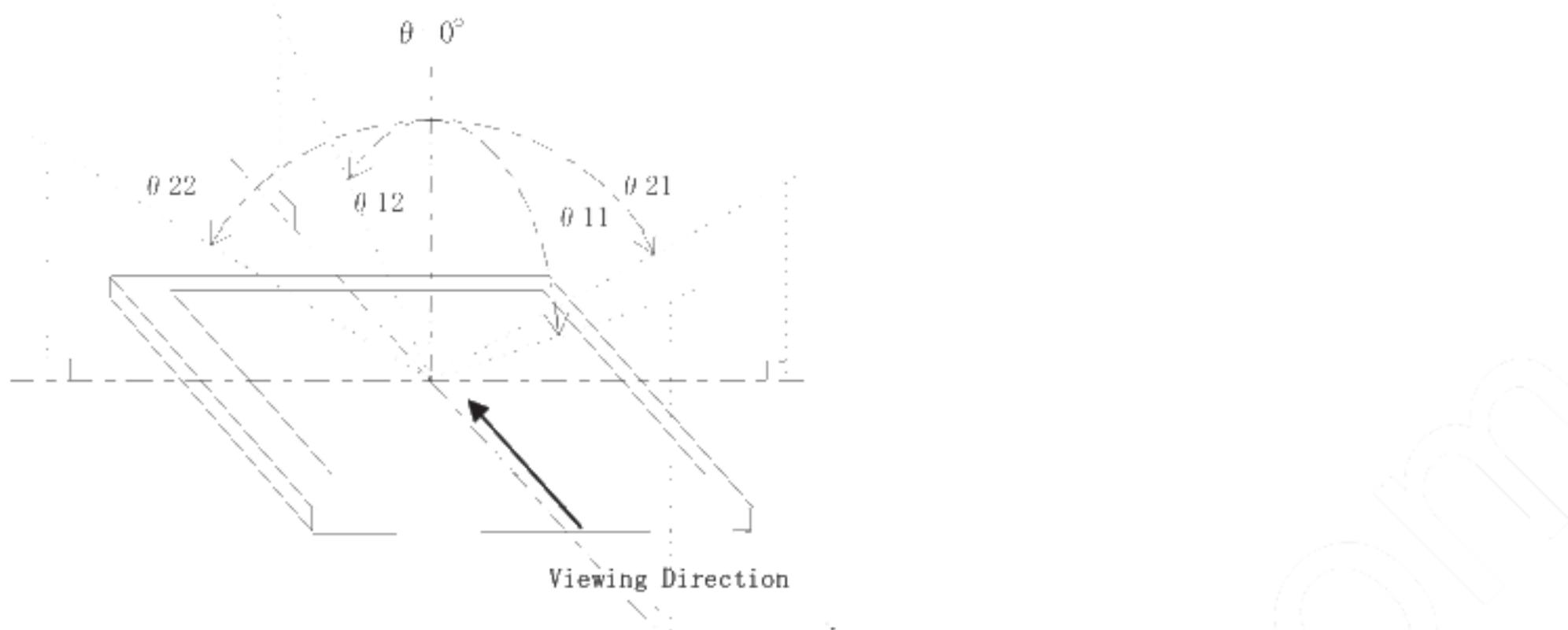


Fig .7 Definition of viewing angle

Note 2) Brightness is measured as shown in Fig.5, and is defined as the brightness of all pixels "White" at the center of display area on optimum contrast.

Photodetector(including luminosity factor)

SR-3

Measurement equipment:
Measuring spot size: 4.9mm ϕ
Measuring field: 1.0°

Center

LCD module
↖

Fig. 8 Optical characteristics Test Method (Brightness)

Note 3) Contrast ratio is defined as follows:

$$Co = \frac{\text{Luminance(brightness) all pixels "White"}}{\text{Luminance(brightness) all pixels "Black"}}$$

Note 4) Uniformity is defined as follows:

$$\text{Uniformity} = \frac{\text{Minimum Luminance(brightness) in 9 points}}{\text{Maximum Luminance(brightness) in 9 points}}$$

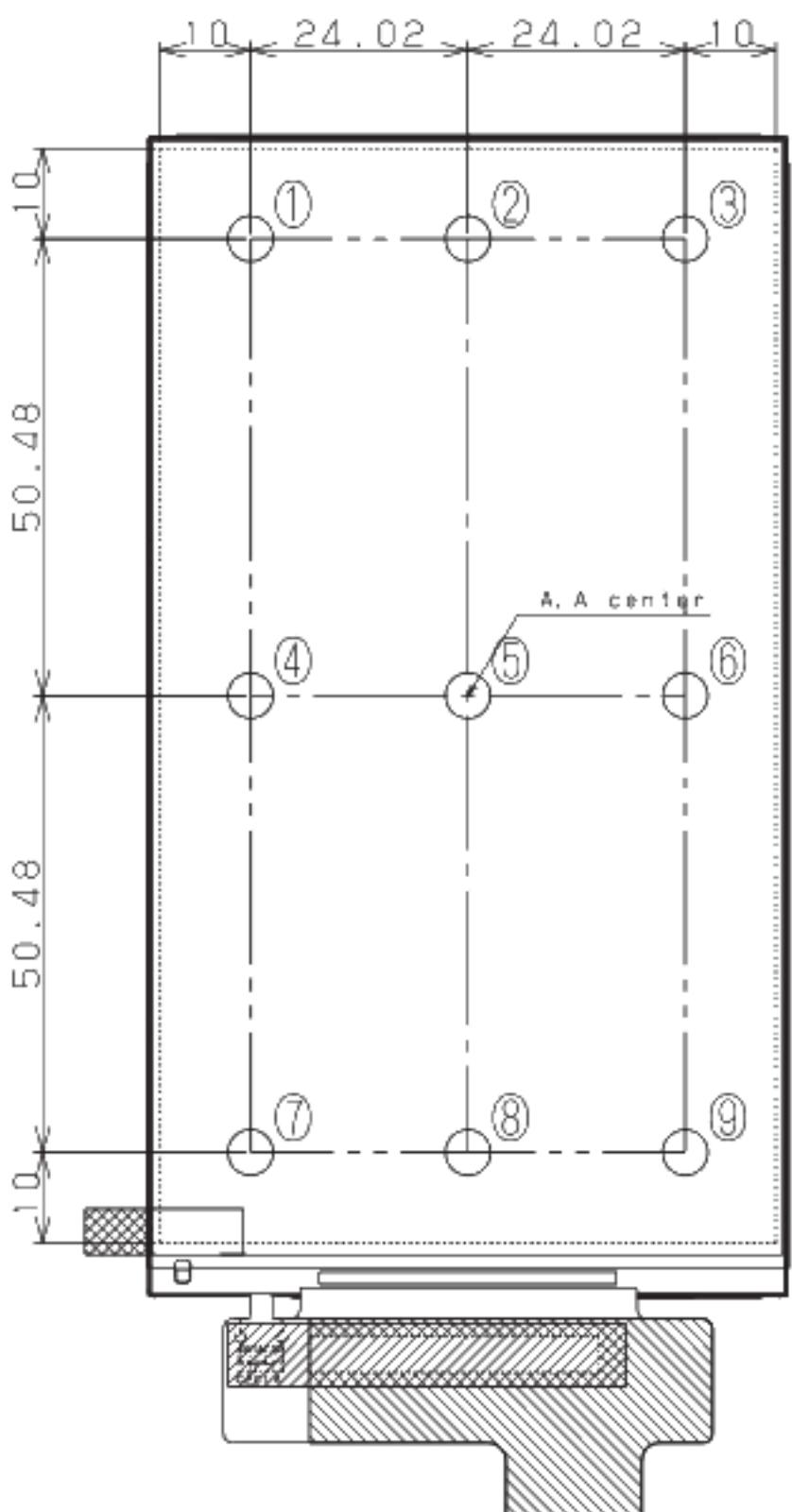


Fig. 9 Measuring Point

Note 5) Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white"

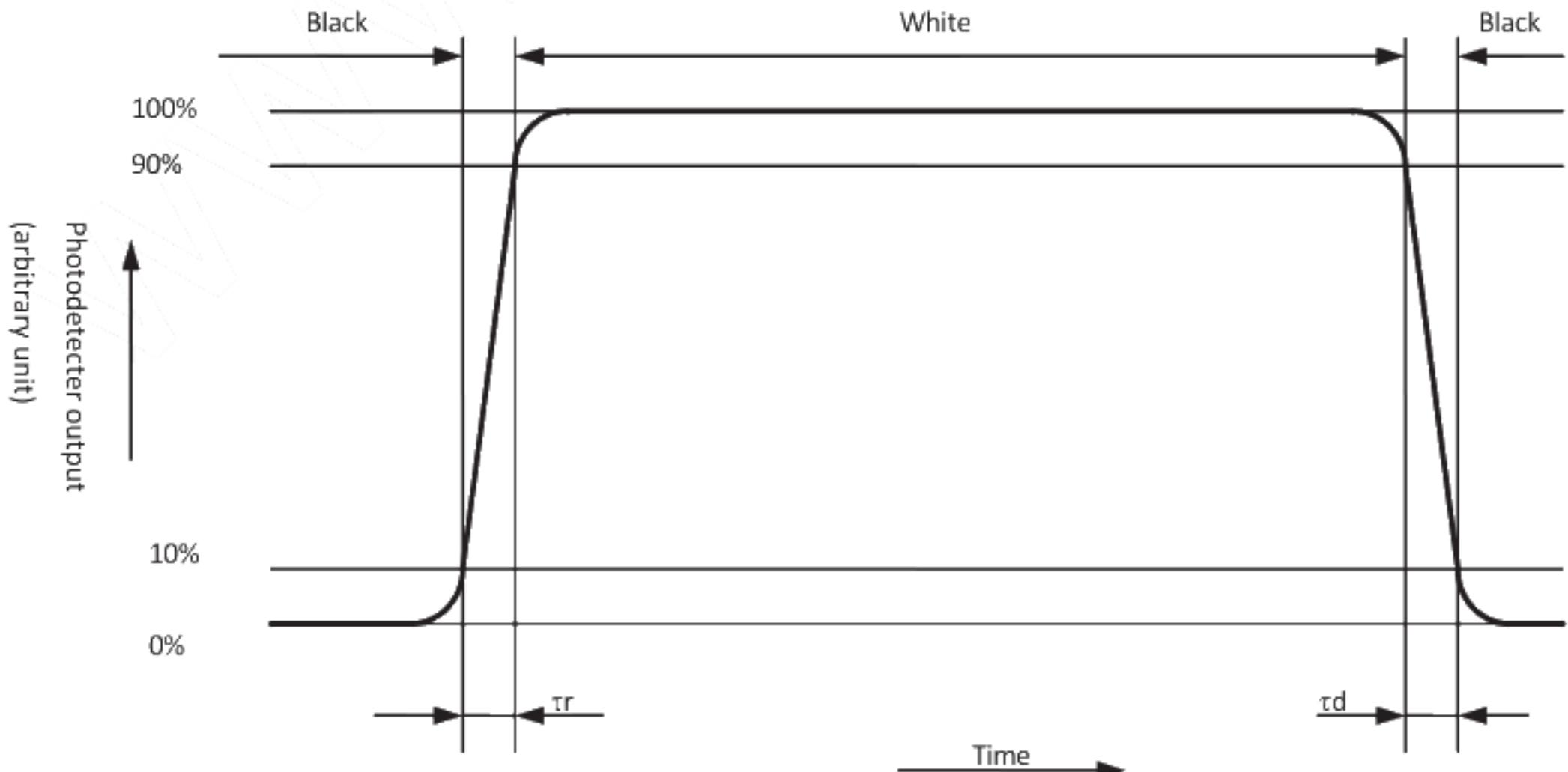


Fig. 10 Definition of response time

10. Reliability

Table.15

| No. | Test | Condition |
|-----|---------------------------------|---|
| 1 | High temperature storage test | Ta=70°C, 240h |
| 2 | Low temperature storage test | Ta=-30°C, 240h |
| 3 | High temperature Operation test | Ta=60°C, 240h |
| 4 | Low temperature Operation test | Ta=-20°C, 240h |
| 5 | Humidity Operation | Ta=40°C 95%RH, 240h |
| 6 | Heat shock test | Ta = -30°C(30min) to 70°C(30min), 20cycle |
| 7 | Electro static discharge test | ±200V, 200pF(0Ω) to Terminals(Contact) (1 time for each terminals) |

* Ta=Ambient temperature

*Check items for other test

In the standard condition, there shall be no practical problems that may affect the display function.

11. Packaging specifications

(11-1) Details of packaging

- 1) Packaging materials: Table.17
- 2) Packaging style : Fig. 11, 12

(11-2) Reliability

1) Vibration test

Table.16

| Item | Test | | | |
|-----------|--|------------|------------|-------|
| | 5 Hz to 50 Hz (3 minutes cycle) | | | |
| Direction | Up-Down, Left-Right, Front-Back (3 directions) | | | |
| Period | Up-Down | Left-Right | Front-Back | Total |
| | 60min | 15min | 15min | 90min |

The frequency should start at 5 Hz and vary continuously.

Total amplitude 20mm 0.2mm 20mm 0.2mm
Frequency 5 Hz 50 Hz 5 Hz 50 Hz (For 9.8m/s²)
 O O O
 |← 3 minutes →|

2) Drop test

Drop height: 900mm
Number of drop: 10 times (Drop sequence: 1 corner, 3 edges, 6 faces)

(11-3) Packaging quantities

240 modules per master carton

(11-4) Packaging weight

About 12 kg



(11-5) Packaging outline dimensions

365 mm × 580 mm × 279 mm (H)

(Packaging materials)

Table.17

| | Parts name | Materials |
|---|--------------------|--|
| 1 | Master carton | Corrugate card board |
| 2 | Inside sleeve | Corrugate card board |
| 3 | Outside sleeve | Corrugate card board |
| 4 | Tray for packaging | Polystyrene with anti-static treatment + anti-static polystyrene |
| 5 | Protective bag | Polyethylene with anti-static treatment |
| 6 | OPP tape | Polypropylene |
| 7 | Bar code label | Anti-static polyethylene |

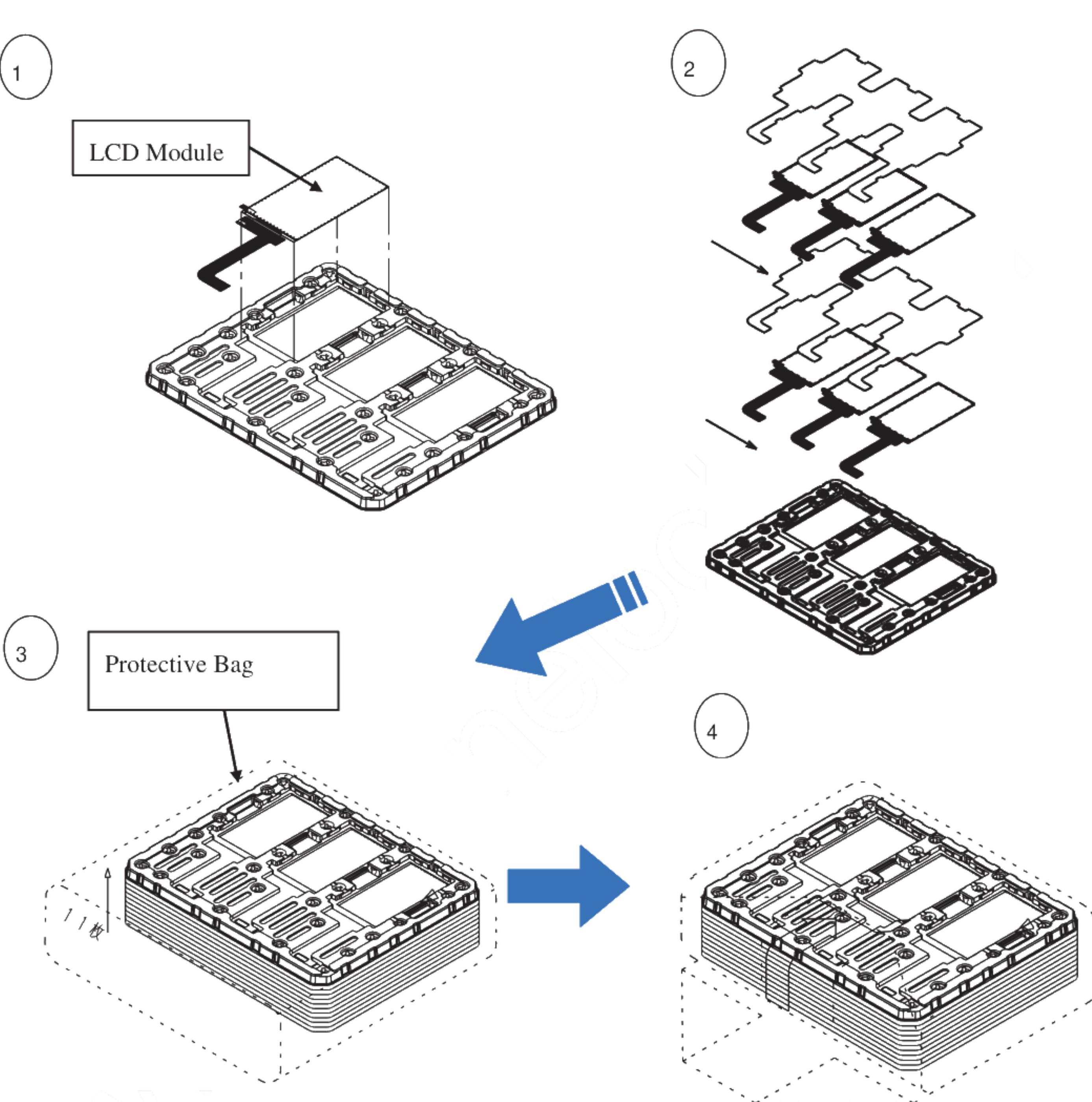


Fig.11 Packaging style (Tray for packaging)

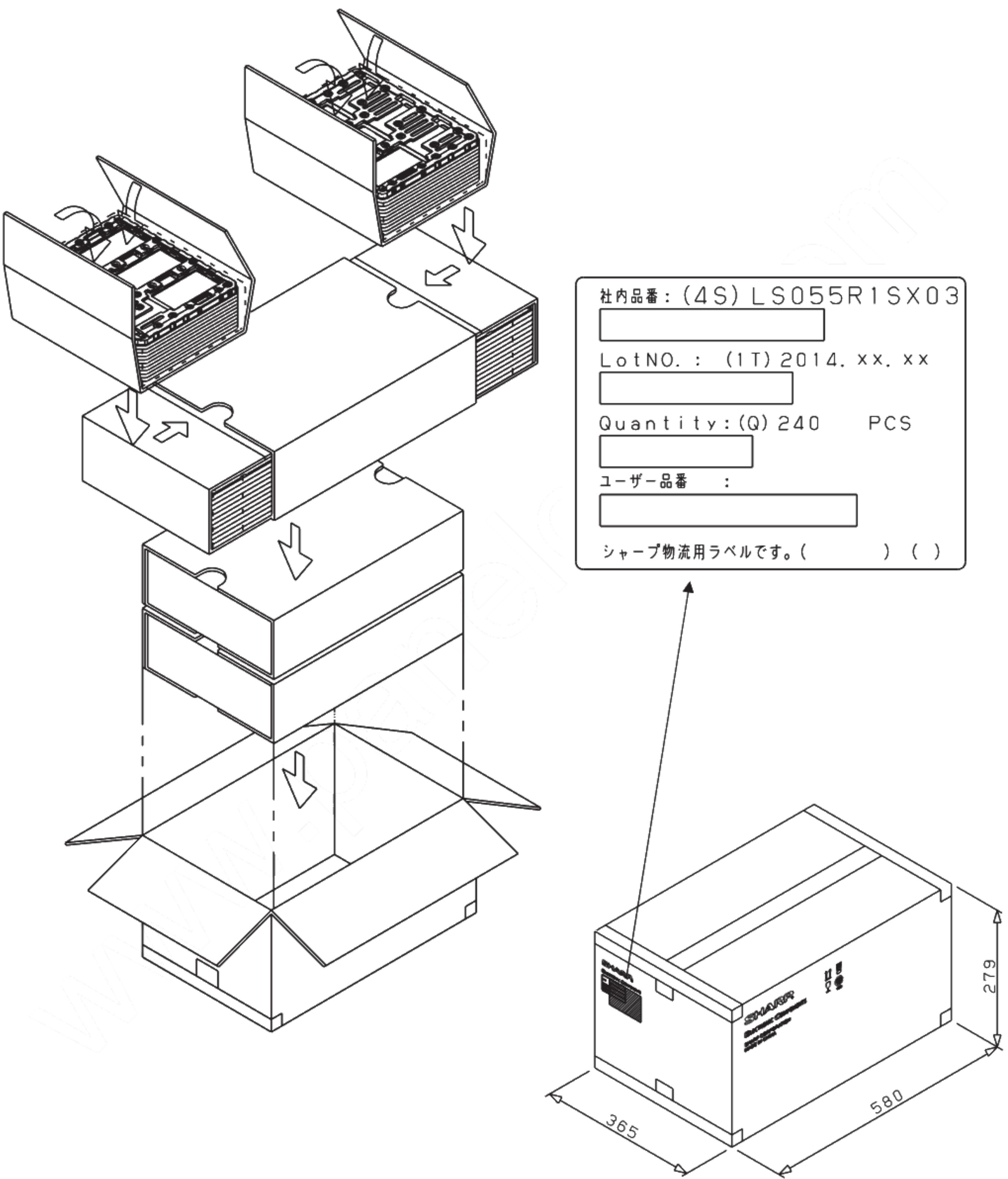


Fig. 12 Packaging style (Master carton for packaging)

12. Serial Number Label identification

Numbering is specified as follows.



03* 4 6 000001 Q

① ② ③ ④ ⑤

① LCD module code : 03* , * = " "(space) or "C"

② product year (lower 1 digits)

4: 2014

5: 2015

③ product month

1: January

2: February

3: March

:

9: September

X: October

Y: November

Z: December

④ serial number

000001 ~ 999999

⑤ factory code

13. LCD Module Code Rule

LS 055 R 1 S X 03

① ② ③ ④ ⑤ ⑥ ⑦

① Parts type

CGS LCD

② Active area size

5.46inch

③ Dot format

WQHD format

④ LCD type

Transmissive

⑤ Interface type

MIPI DSI 4 Lane, 2ports

⑥ Polarizer / LCD viewing type

Clear type / Wide viewing angle

⑦ Serial Code

14. Outline dimensions

B

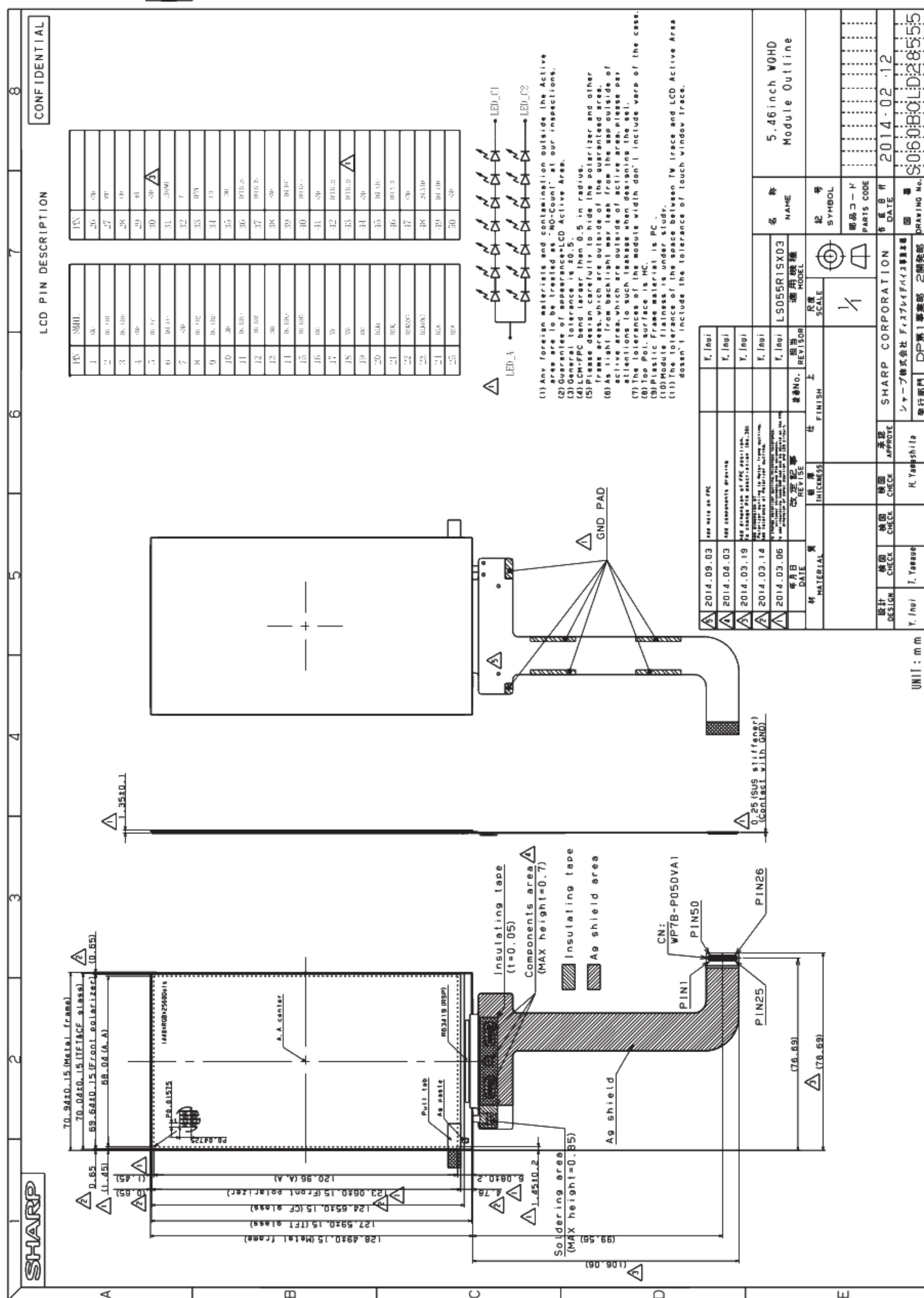


Fig. 13 Outline dimensions